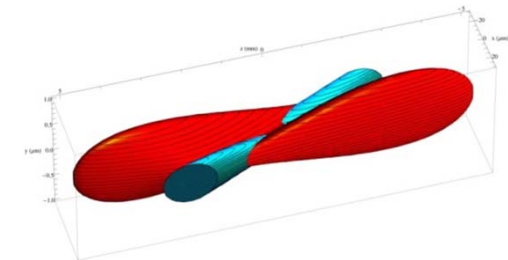
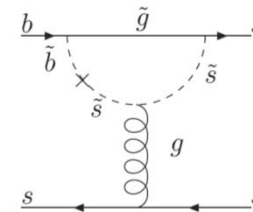




Future Experiments on CP Violation

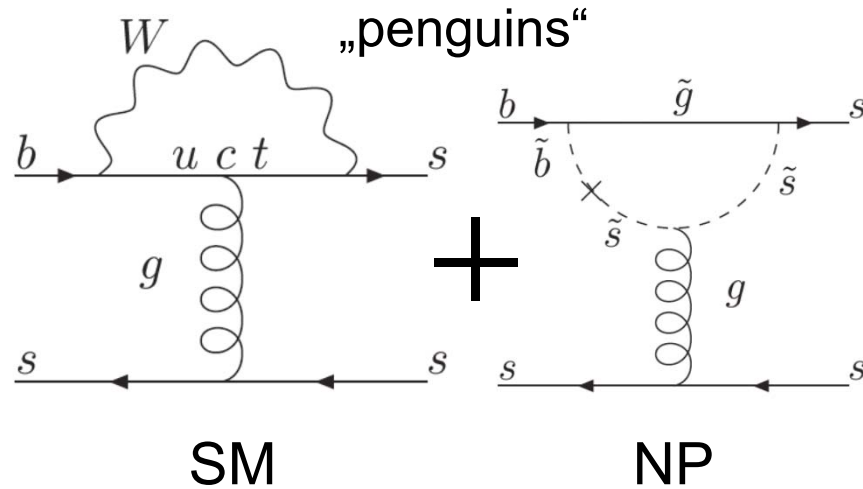
Christian Kiesling
Max-Planck-Institute for Physics, Munich

- Physics Motivation
- LHCb Upgrade
- A new generation of B-Factories: SuperB and SuperKEKB
- Conclusions





New Physics at the Loop Level



Rare Decays of B mesons:

$$B \rightarrow X_{s,d} \gamma \quad \mathcal{O}(10^{-4})$$

$$B \rightarrow X_{s,d} l^+ l^- \quad \mathcal{O}(10^{-6})$$

$$B \rightarrow X_d \nu \bar{\nu} \quad \mathcal{O}(10^{-6})$$

$$B_s \rightarrow l^+ l^- \quad \mathcal{O}(10^{-9})$$

SM pred.

NP in CPV asymmetries:

$$B \rightarrow J/\psi K_s \longleftrightarrow B \rightarrow \phi K_s$$

Principle:

Deviation of observable from the SM prediction signals NP

virtual particles in the loop $\longrightarrow \Lambda_{NP}$
 reveal their existence

leptons:

$$\left. \begin{aligned} \tau &\rightarrow \mu \gamma \\ \tau &\rightarrow \mu \mu \mu \\ \tau &\rightarrow \mu \eta \end{aligned} \right\} \text{NP could make these decays possible}$$

need precision (statistics) to challenge the SM



LHCb vs Super Flavor Factories

+ LHCb

large samples (but low efficiencies)

B_s oscillations

B_c , bottom baryons

$B_{s,d}^0 \rightarrow \mu\mu$

$B \rightarrow J/\psi K_S$

$D^0 \rightarrow K^+ \pi^-, K^+ K^-$

+ Super B Factories

generally more final states
esp. with photons, missing energy

rare decays, such as

$B^+ \rightarrow l^+ \nu, B^+ \rightarrow K^+ \nu \bar{\nu}$

$b \rightarrow s \gamma, b \rightarrow s l^+ l^-$

inclusive processes

$B \rightarrow J/\psi \phi, \pi\pi, \rho\pi, \rho\rho, \pi\pi\pi$

$D^0 \bar{D}^0$ mixing

LHCb and Super B Fact. will run concurrently. \rightarrow largely complementary



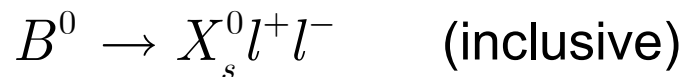
Energy reach of the Super Flavor Factories

No flavor structure for NP: $\Lambda_{NP} \geq 100 - 1000 \text{ TeV}$ „NP flavor problem“

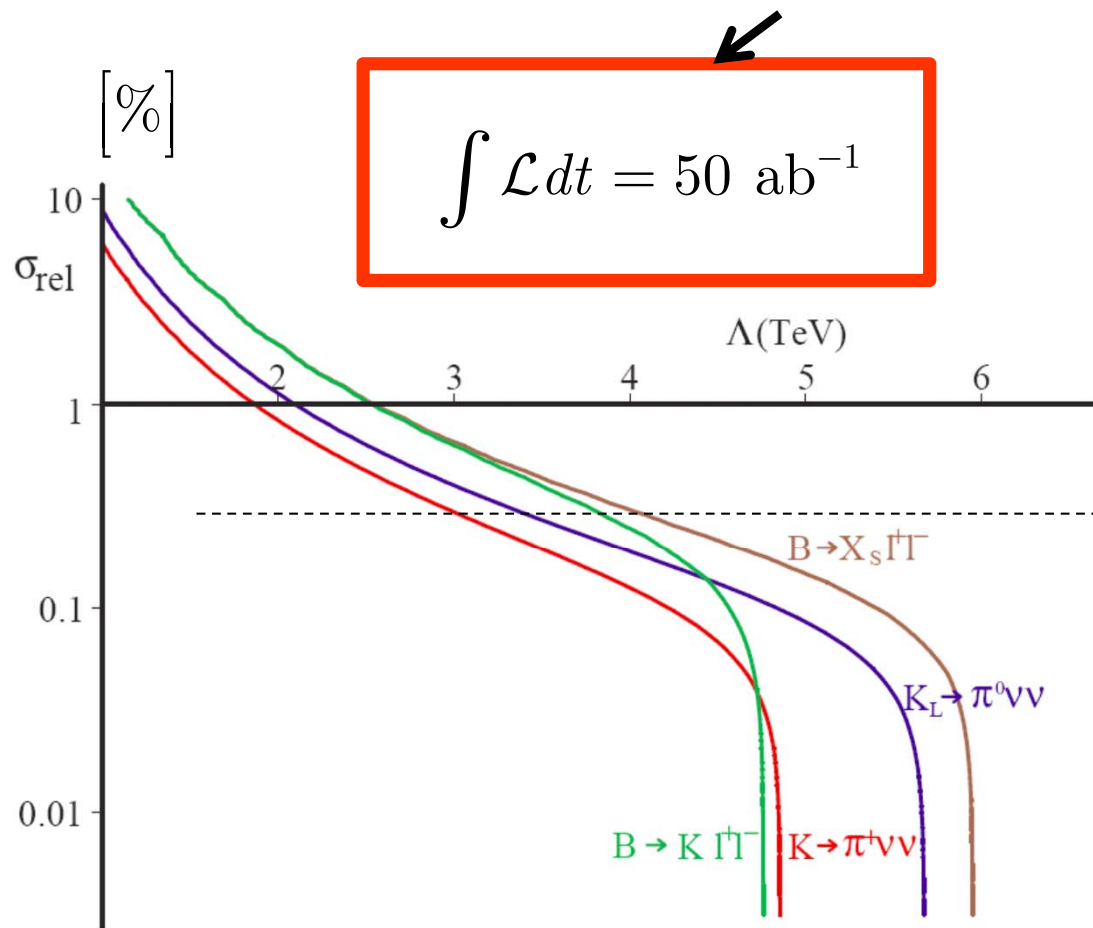
Look for FCNC processes (highly suppressed in SM): $\sim 2 \text{ OoM increase}$

Assumption on NP flavor sector:
Minimal Flavor Violation (MFV)

Measure, e.g., the decay rates:



-
-
-
-





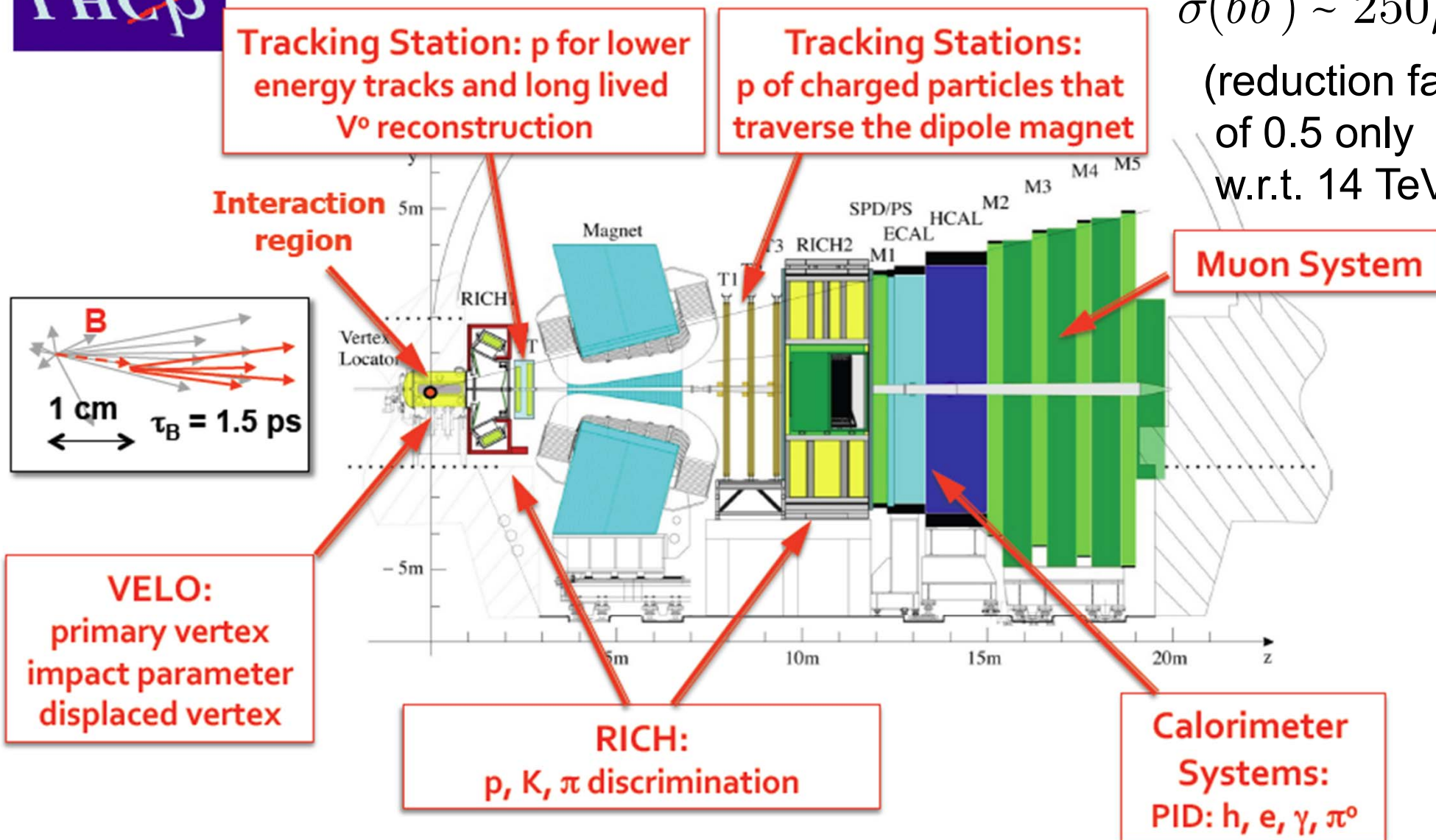
Upgrade Program for LHCb



LHCb Detector

7 TeV:

$\sigma(b\bar{b}) \sim 250 \mu\text{b}$
(reduction fact.
of 0.5 only
w.r.t. 14 TeV)



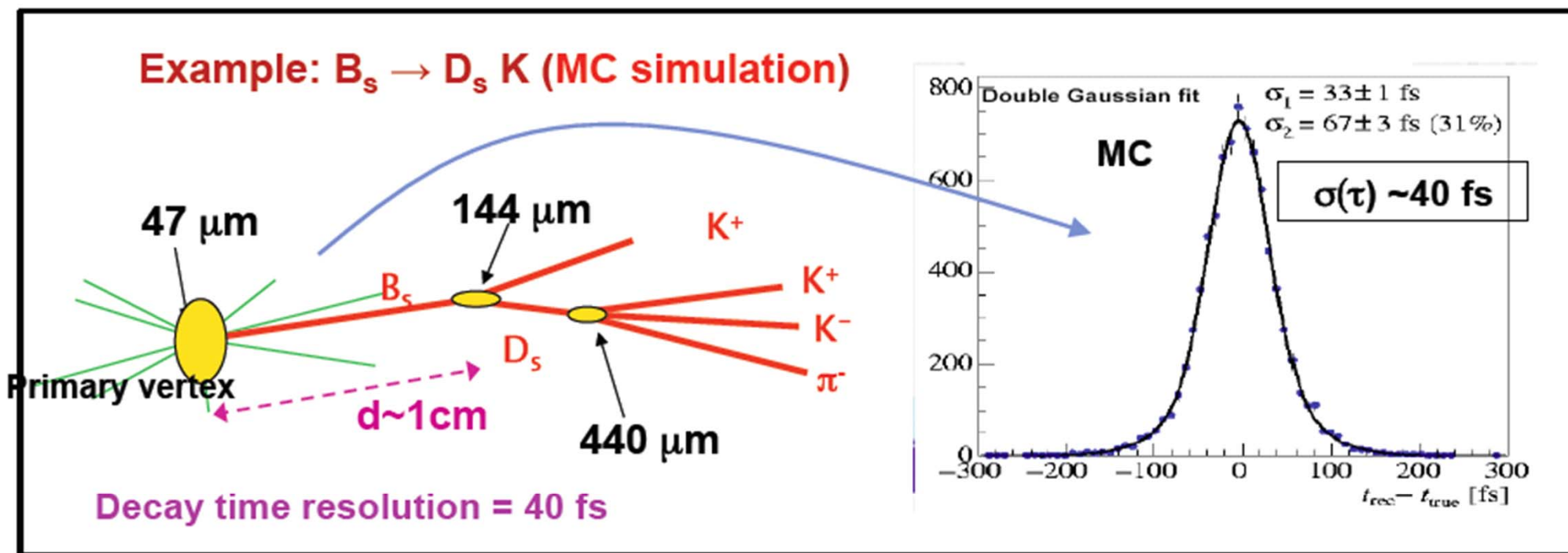


LHCb Trigger & DAQ System



Forward spectrometer: huge particle flux even at deliberately reduced lumi @LHCb (operate @ 2×10^{32})

How to survive @ LHC design luminosities:

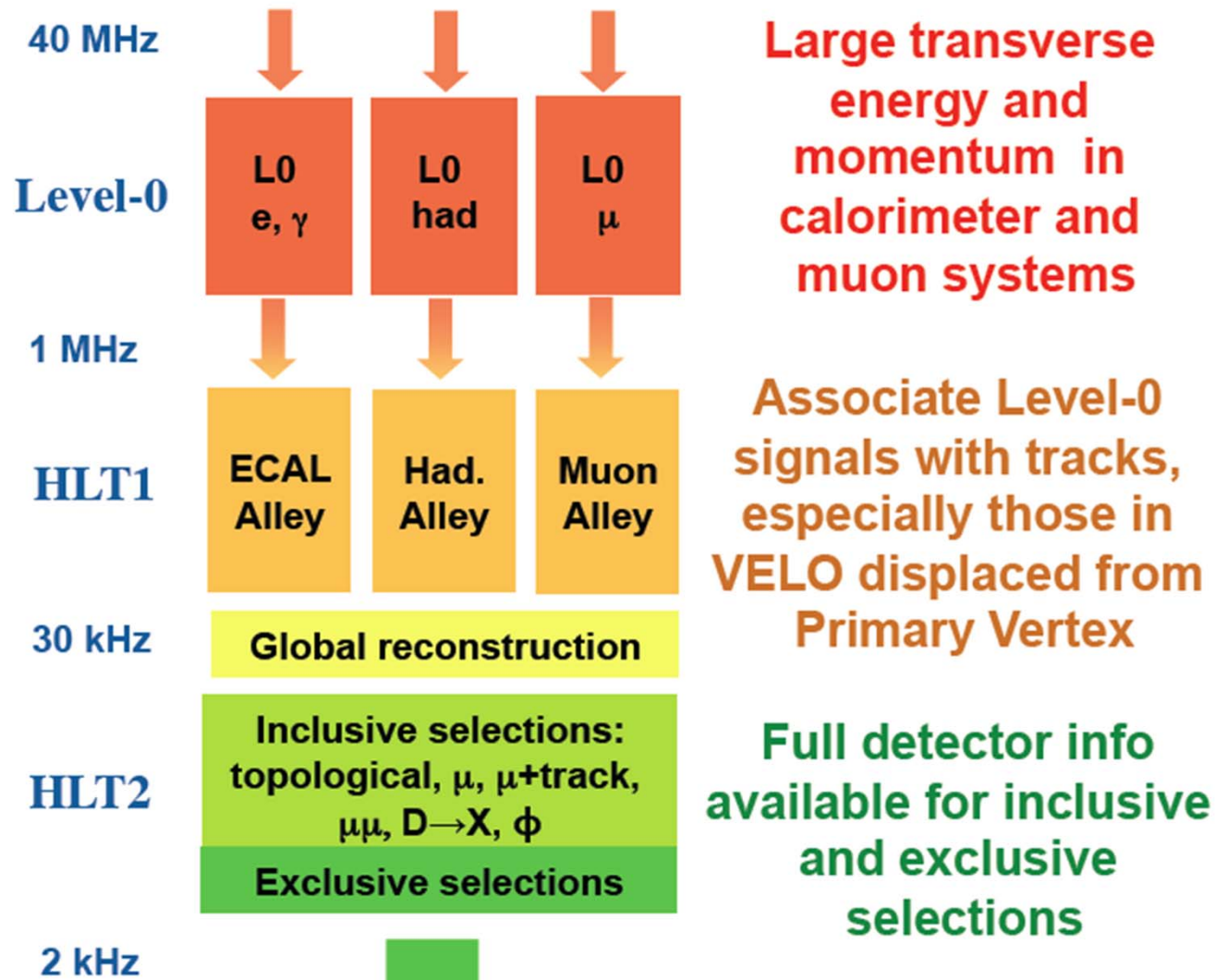


Trigger on impact parameter

Measurement of decay distance (and then proper decay time)



LHCb Trigger & DAQ System Upgrade



LHC luminosity upgrade planned (2015-2016):

$10 \times L_{\text{design}}$

Bottlenecks @ 2×10^{33} :

1MHz readout rate, long latency ($2.5 \mu\text{s}$)

Ambitious Solution:

increase R/O to 40MHz, S/W trigger @ 30MHz on CPU farm

Replace VELO & essentially the entire F/E electronics



Strategies for High Luminosity @ Super BF's

$$\mathcal{L} = \frac{N_+ N_- f}{4\pi\sigma_x\sigma_y} R \quad \text{basic formula for the (instantaneous) luminosity}$$

Accelerator physicists usually like this one better:

$$\mathcal{L} = \frac{\gamma_+}{2er_e} \left(1 + \frac{\sigma_y}{\sigma_x} \right) \left(\frac{I_+ \xi_{y,+}}{\beta_y} \right) \left(\frac{R}{R_{\xi_y}} \right)$$

Annotations in the diagram:

- stored current** points to I_+
- tune shift** points to $\xi_{y,+}$
- vertical beta function at IP** points to β_y

$R_{,\xi}$: reduction factors (geometrical)

$\sigma_{x,y}$: beam spot size at IP

beam-beam parameter (or tune shift)

$$\xi_{y,+} = \frac{r_e}{2\pi\gamma_+} \left(\frac{\beta_y N_-}{\sigma_x (\sigma_x + \sigma_y)} \right) R_{\xi_y}$$

$$\sigma_{x,y} = \sqrt{\varepsilon_{x,y} \beta_{x,y}}$$

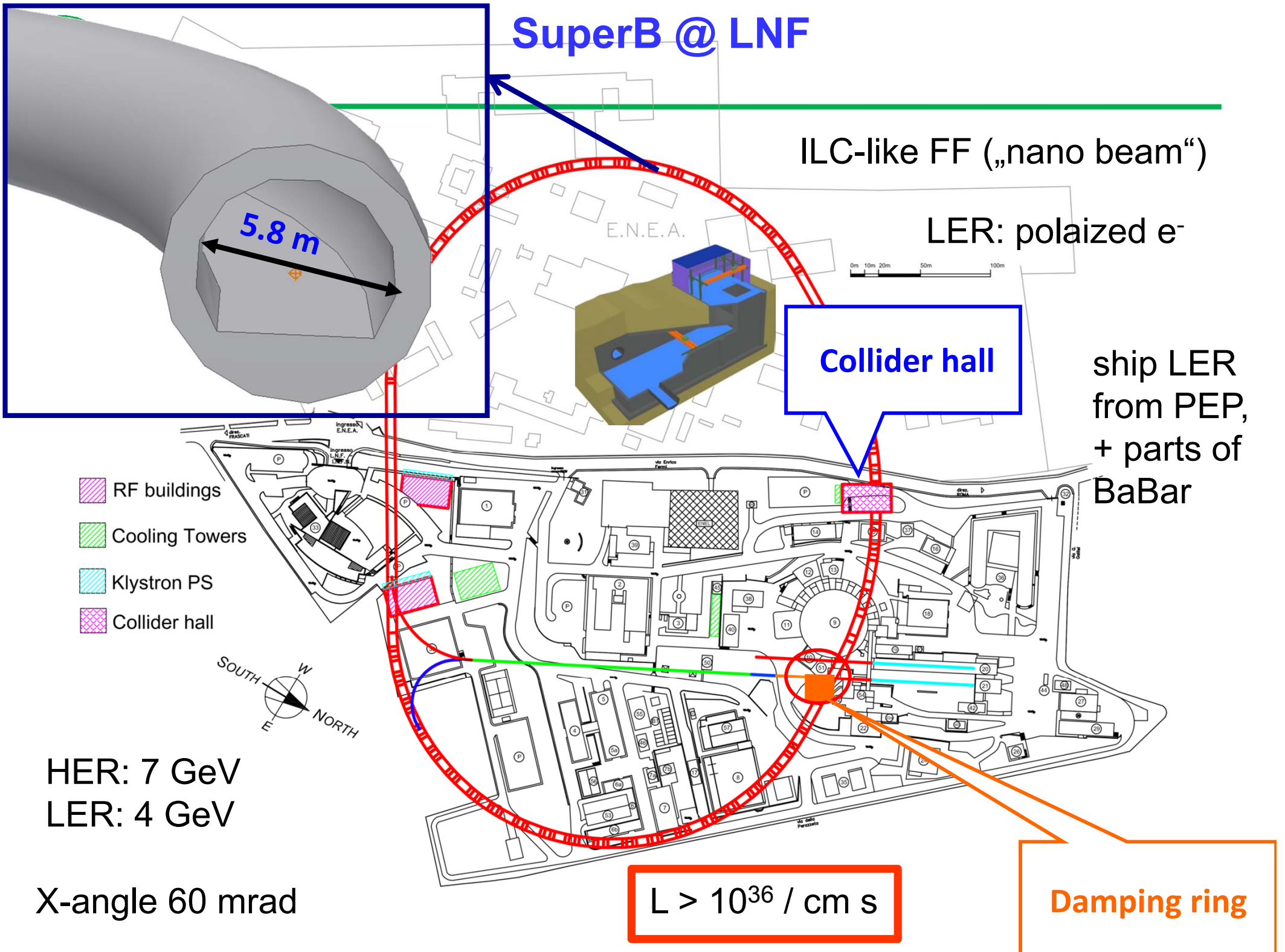
beam emittance (need damping ring(s))

SuperB Project (INFN)



Proto-Collaboration:
Italy, USA, France, Russia, Poland,
UK, Spain, Canada

SuperB @ LNF



ILC-like FF („nano beam“)

LER: polarized e^-

Collider hall

ship LER
from PEP,
+ parts of
BaBar

- RF buildings
- Cooling Towers
- Klystron PS
- Collider hall



HER: 7 GeV
LER: 4 GeV

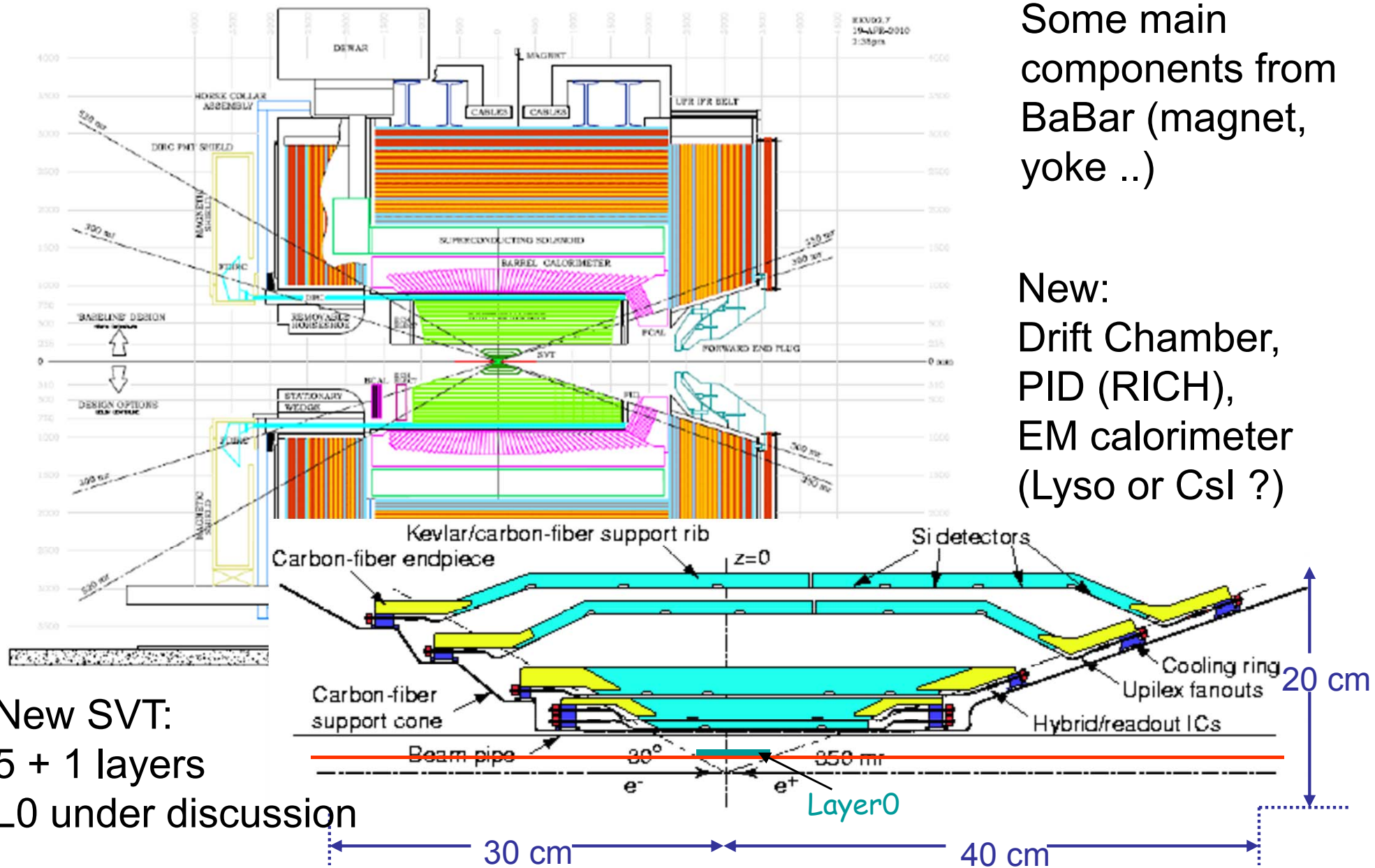
X-angle 60 mrad

$$L > 10^{36} / \text{cm s}$$

Damping ring



SuperB Detector





SuperB Project Status

Toward green light

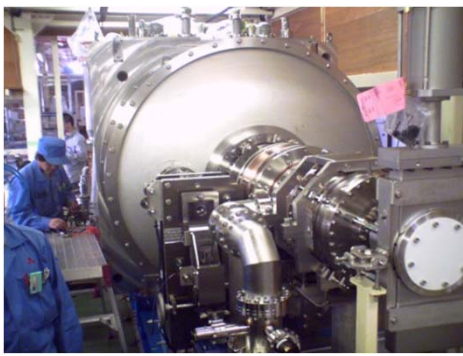
- The project is the first “flagship project” of the new national research plan
- The project has been mentioned as a reciprocity condition in a russian italian agreement on ignitor (nuclear fusion)
- A formal commitment with INFN for the project with the declaration of some available budget in the current year is expected
- This commitment will set the start of the project

Foil from
recent
presentation
by M. Giorgi

SuperKEKB and Belle-II

1.7 A e^-
1.4 A e^+

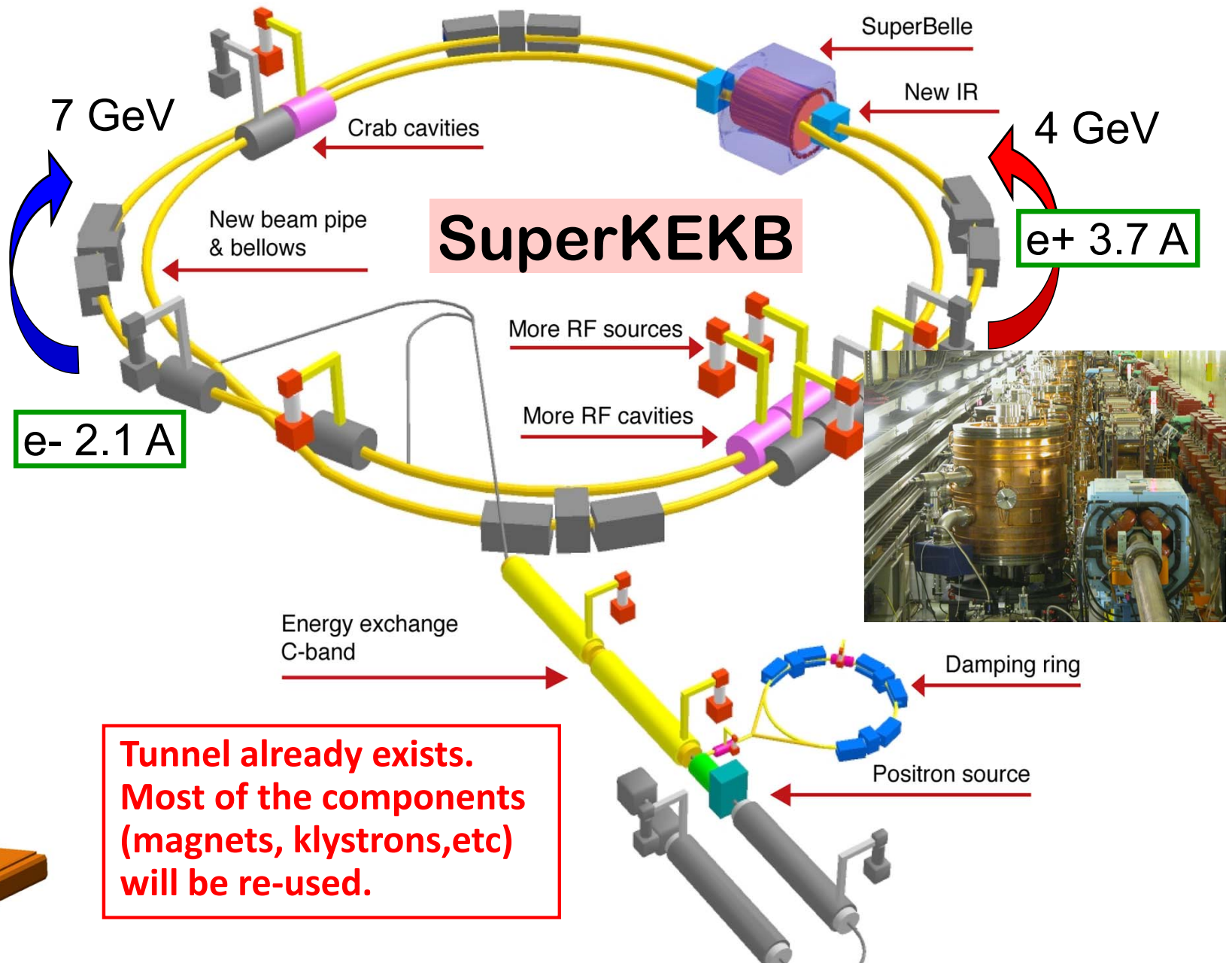
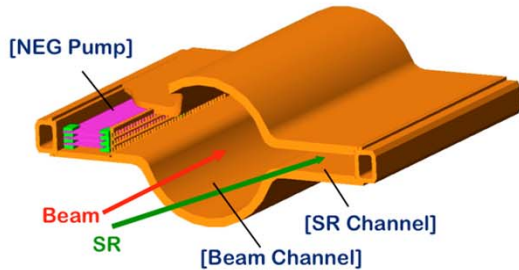
**Belle-II Collaboration founded in Dec. 2008
now over 300 members from
47 institutions and 13 countries
strong European participation:
Austria, Germany, Czech Republic,
Poland, Spain, Slovenia,
(mainly in Pixel Vertex Detector,
Si Strip Detector)**



Crab cavity (High-Current Option)



Upgrade of superconducting cavities



**Tunnel already exists.
Most of the components
(magnets, klystrons, etc)
will be re-used.**

Goal: reach $> 8 \times 10^{35} \text{ cm}^{-2}\text{s}^{-1}$



Comparison of Options

	KEKB Design	KEKB Achieved (): with crab	SuperKEKB High-Current Option	SuperKEKB Nano-Beam Option
β_y^* (mm)(LER/HER)	10/10	6.5/5.9 (5.9/5.9)	3/6	0.21/0.37
ε_x (nm)	18/18	18/24(15)	24/18	2.8/1.6
σ_y (μm)	1.9	1.1 (0.84)	0.85/0.73	0.070/0.052
ξ_y	0.052	0.108/0.056 (0.101/0.096)	0.3/0.51	0.07/0.07
σ_z (mm)	4	~ 7	5(LER)/3(HER)	6
I_{beam} (A)	2.6/1.1	1.8/1.45 (1.62/1.15)	9.4/4.1	3.70/2.13
N_{bunches}	5000	1387 (1585)	5000	2778
Luminosity ($10^{34} \text{ cm}^{-2} \text{ s}^{-1}$)	1	1.76 (2.11)	53	80

High Current Option includes crab crossing and travelling focus.
Nano-Beam Option does not include crab waist yet

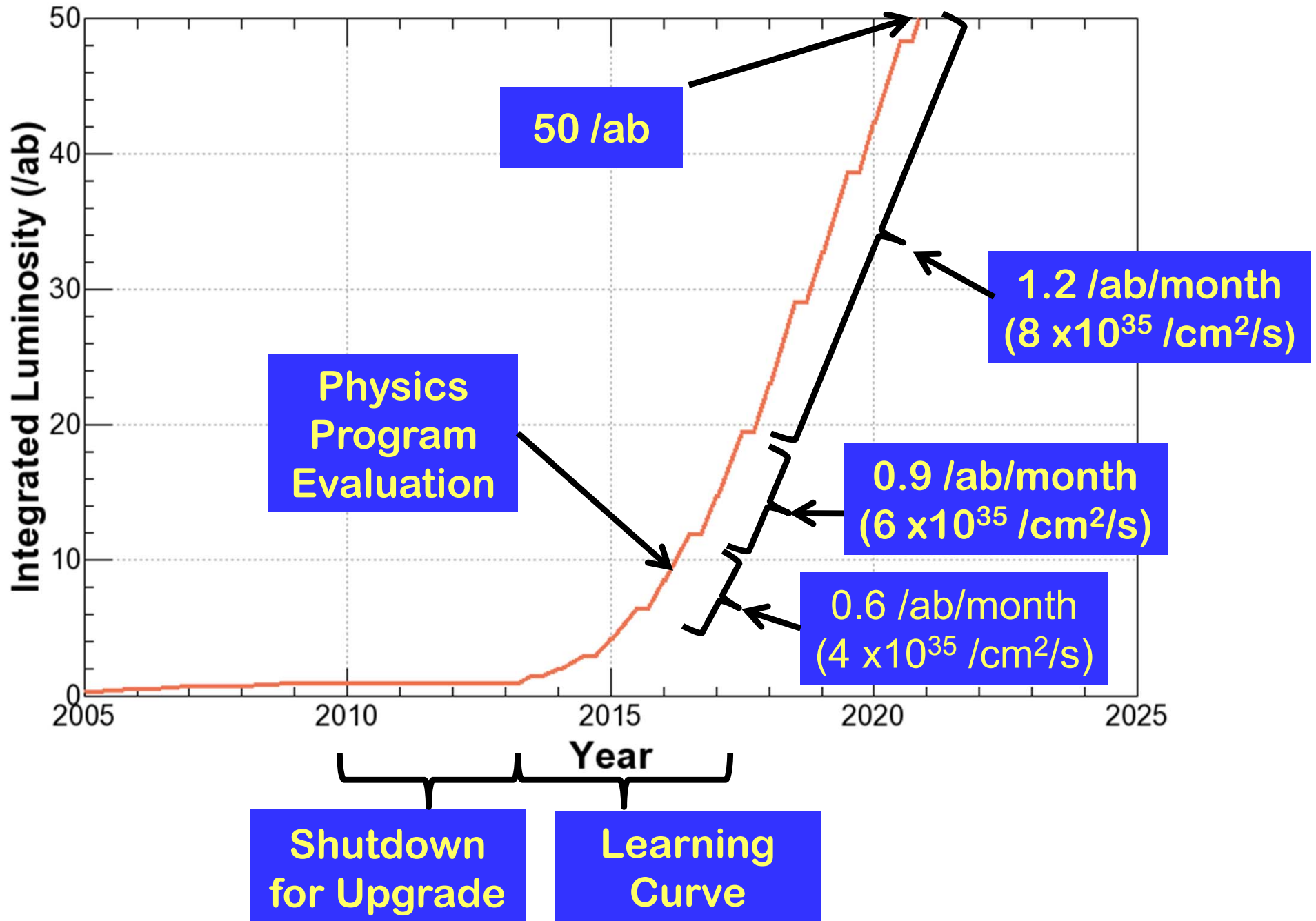
**Nano-opt
chosen**



Major Machine Components to Upgrade

- New ante-chamber beam pipes for both rings
 - 3km x 2 in total
 - Al/Cu for LER/HER
 - Mitigation techniques for suppression of electron cloud
- New IR optics
 - New superconducting/permanent magnets around IP
 - Optimization of the compensation solenoid
- Additional normal magnets to reduce emittance
 - Replace dipoles & change the wiggler layout for LER
- New HER arc lattice
- More precise magnet setting \Leftrightarrow power supplies
- Rearrangement of existing ARES cavities with additional power sources
- New positron damping ring and new positron target
- New RF gun for electrons with reduced emittance

Expected Luminosity Development





Funding Situation of the Machine

KEKB upgrade plan has been approved

June 23, 2010 High Energy Accelerator Research Organization (KEK)

The MEXT, the Japanese Ministry that supervises KEK, has announced that it will appropriate a budget of 100 oku-yen (approx \$110M) over the next three years starting this Japanese fiscal year (JFY2010) for the high performance upgrade program of KEKB. This is part of the measures taken under the new “Very Advanced Research Support Program” of the Japanese government.

“We are delighted to hear this news,” says Masanori Yamauchi, former spokesperson for the Belle experiment and currently a deputy director of the Institute of Particle and Nuclear Studies of KEK. “This three- year upgrade plan allows the Belle experiment to study the physics from decays of heavy flavor particles with an unprecedented precision. It means that KEK in Japan is launching a renewed research program in search for new physics by using a technique which is complementary to what is employed at LHC at CERN.”



Detector for SuperKEKB: Belle-II

Much higher backgrounds from SuperKEKB !!

7 GeV e⁻

„backward“

KLM („K_L μ“, barrel)

KLM (endc.)

ECL (CsI (TI))

ECL (CsI)

CDC

PID

ECL (CsI)

4 GeV e⁺

„forward“

SVD

PXD

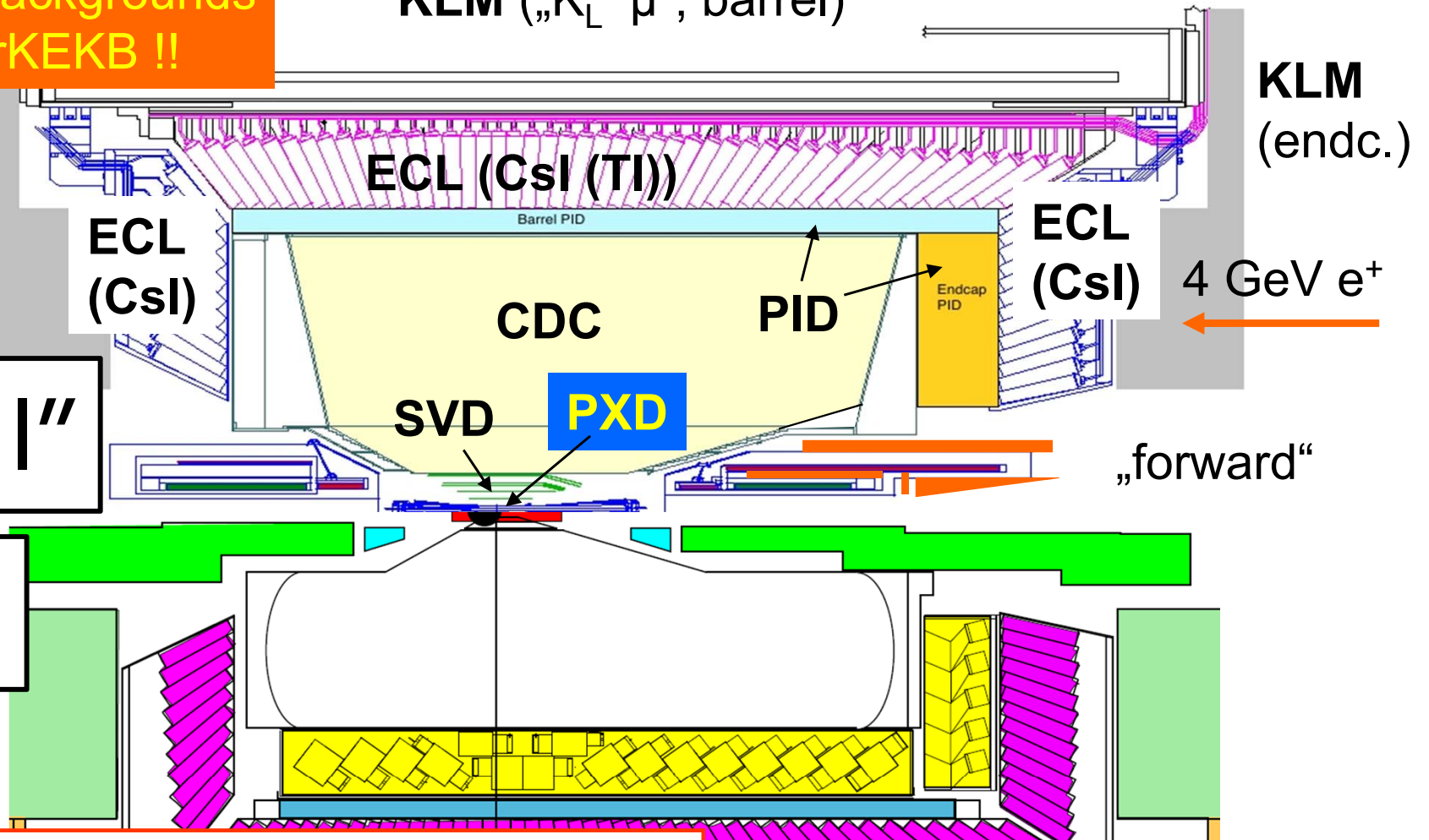
Endcap PID

“Belle II”

Belle

SVD: 4 lyr -> 2 DEPFET layers + 4 DSSD layres
 CDC: small cell, long lever arm
 ACC+TOF -> TOP+A-RICH
 ECL: waveform sampling, pure CsI for end-caps
 KLM: RPC -> Scintillator +SiPM (end-caps)

new dead time free
 readout and
 high speed
 computing systems

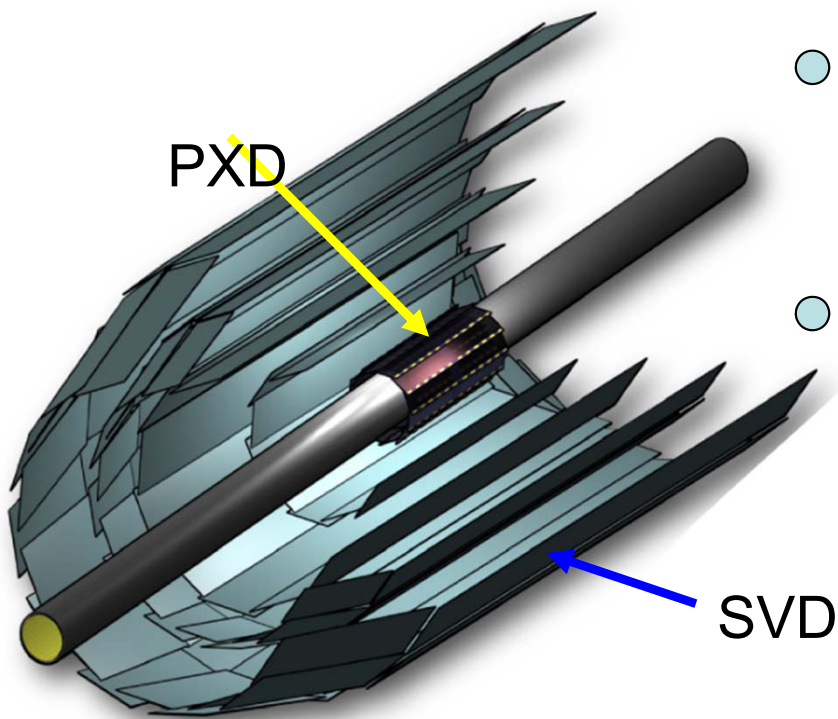




Silicon Tracking System @ Belle-II

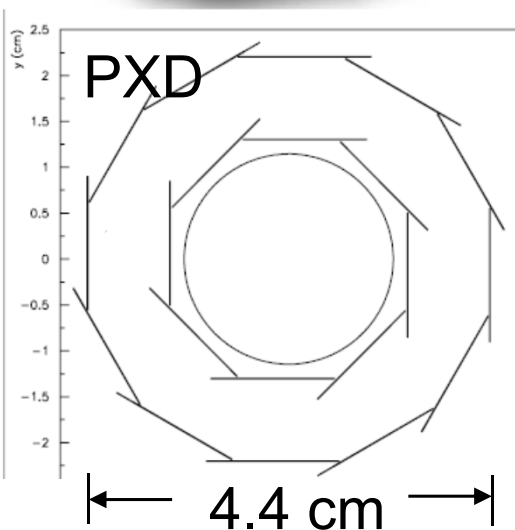


Nano beam option: 1 cm radius of beam pipe



- 2 layer Si pixel detector (DEPFET technology) (R = 1.4, 2.2 cm) ← „PXD“
monolithic sensor thickness 75 μm (!), pixel size $\sim 50 \times 50 \mu\text{m}^2$
- 4 layer Si strip detector (DSSD) (R = 3.8, 8.0, 11.5, 14.0 cm) ← „SVD“

Significant improvement in z-vertex resolution

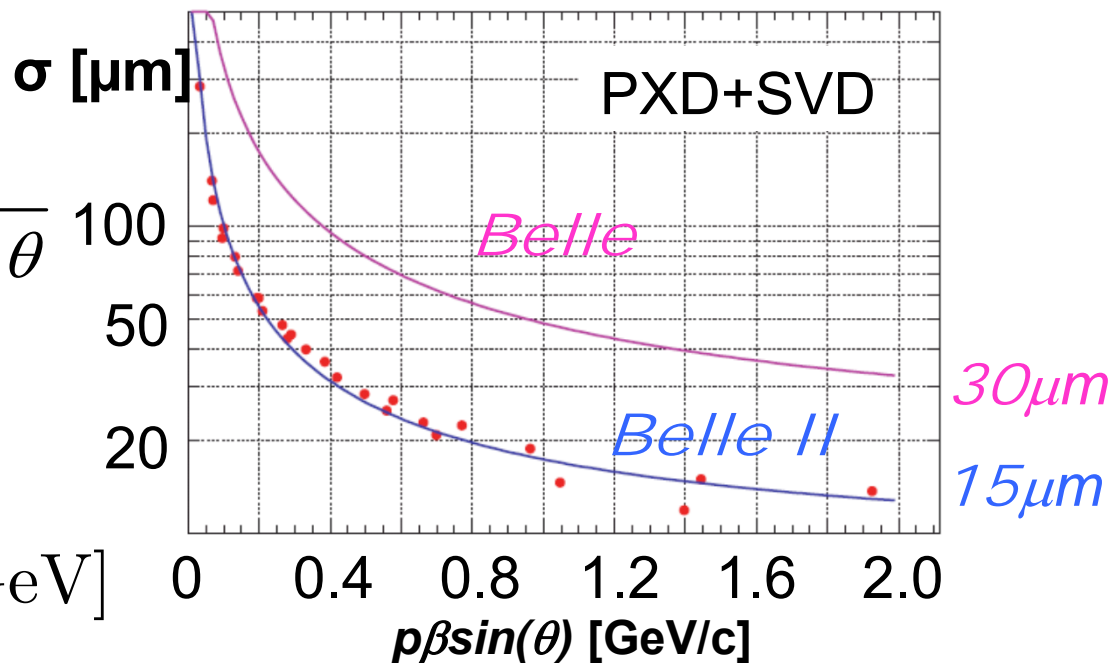


$$\sigma = a + \frac{b}{p\beta \sin^{5/2} \theta}$$

Belle II:

$$a = 8.5 [\mu\text{m}]$$

$$b = 9.6 [\mu\text{m GeV}]$$





Conclusions

- „New Physics“ needed to explain the observed matter-antimatter asymmetry → new sources of CP violation
- A new generation of B factories planned to search for NP, complementary to the LHC program. LHCb plans for trigger upgrade
- At KEK (Japan), the SuperKEKB project is well under way:
Strong contribution from Europe (pixel vertex detector)
Initial funding by Japanese Government of 100 M\$ granted:

→ „Green Light“ for SuperKEKB
- Plan to have machine and detector ready for data taking by early 2014
- SuperB Project in Frascati under discussion using „nano beams“ (this scheme was also adopted by SuperKEKB)
initial funding not yet secured
- Excellent prospects for flavor physics during the LHC era



Backup



DEPFET Principle



p-channel FET on a completely depleted bulk

A deep n-implant creates a potential minimum for electrons under the gate (“internal gate”)

Signal electrons accumulate in the internal gate and modulate the transistor current ($g_q \sim 400 \text{ pA/e}^-$)

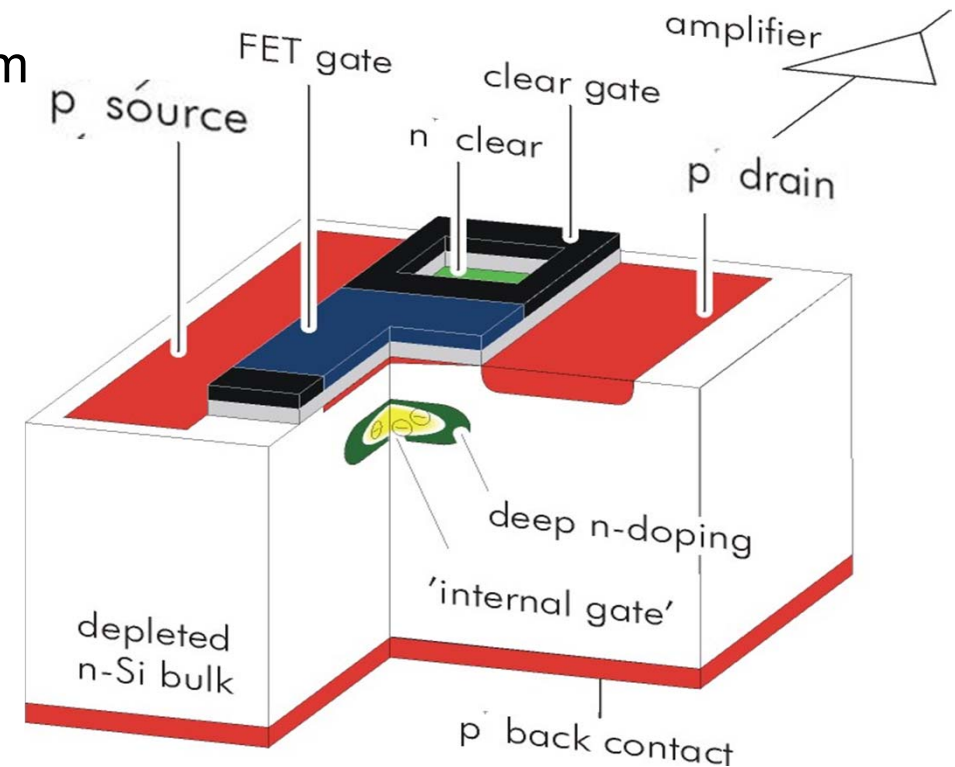
Accumulated charge can be removed by a clear contact (“reset”)

Fully depleted:

→ large signal, fast signal collection

Low capacitance, internal amplification → low noise

Depleted p-channel FET



Transistor on only during readout:
low power

Complete clear → no reset noise

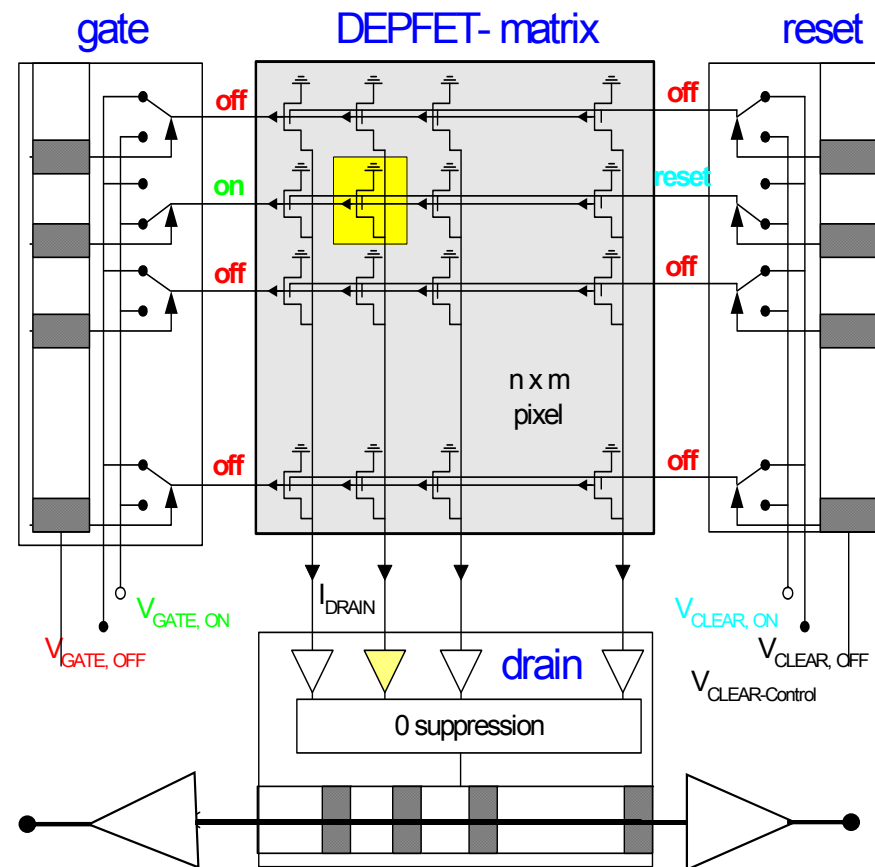


Array of DEPFETs



Row wise read-out ("rolling shutter")

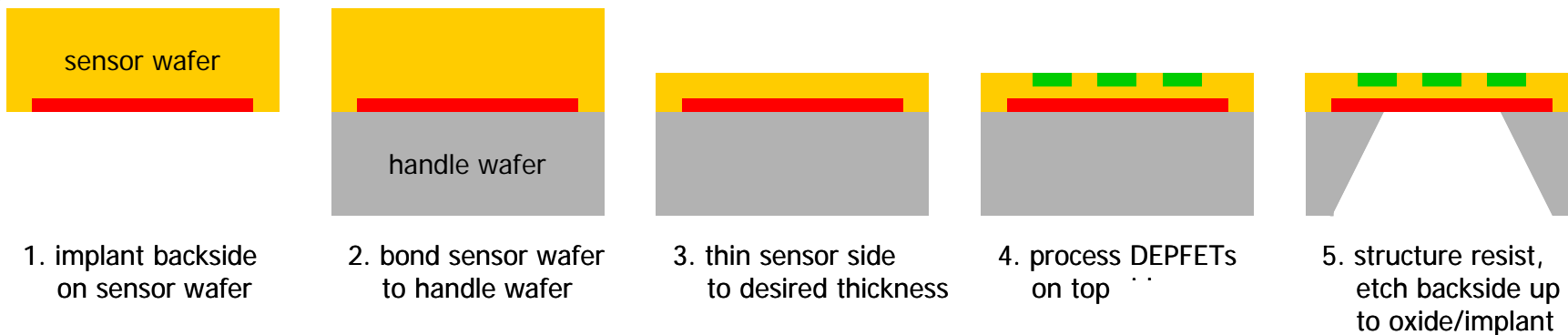
- select row with external gate
read current,
clear DEPFET,
read current again
- the difference is the signal
- only one row active → low power consumption
- two different auxiliary ASICs needed



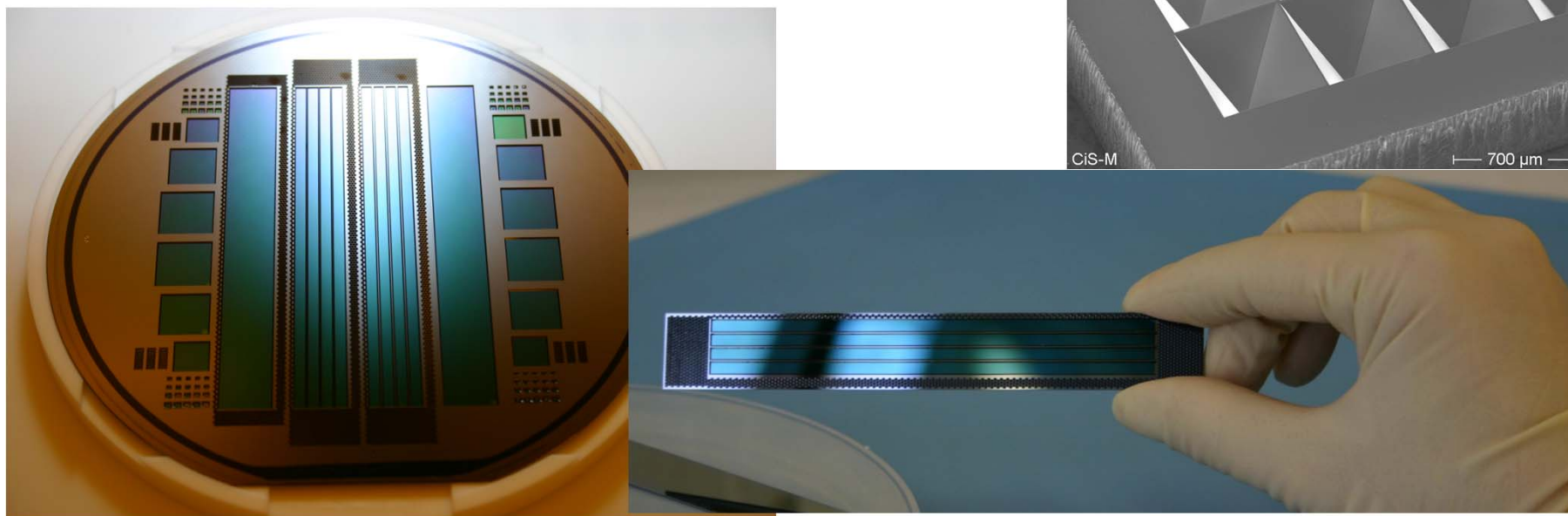
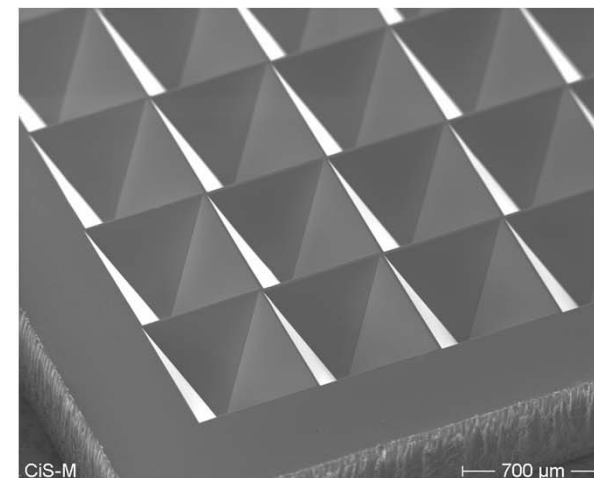
- Switcher
- DCD (drain current digitizer)



Thinning Technology

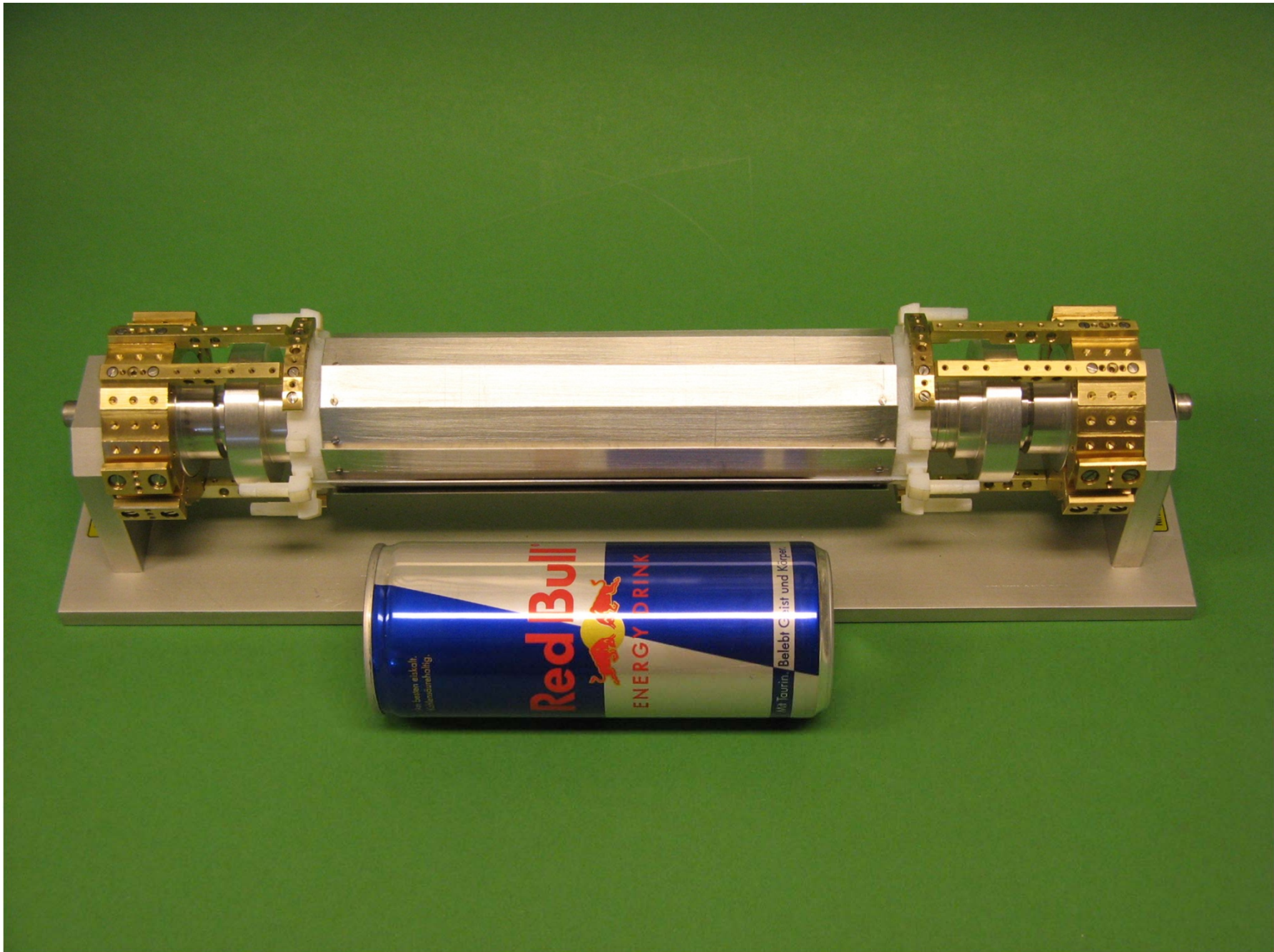


- Sensor wafer bonded on “handle” wafer.
- Rigid frame for handling and mechanical stiffness
- 50 μm thickness produced
- Samples of 10x1.3 cm^2 & frame of 1 & 3 mm width
- Electrical properties ok (diodes)



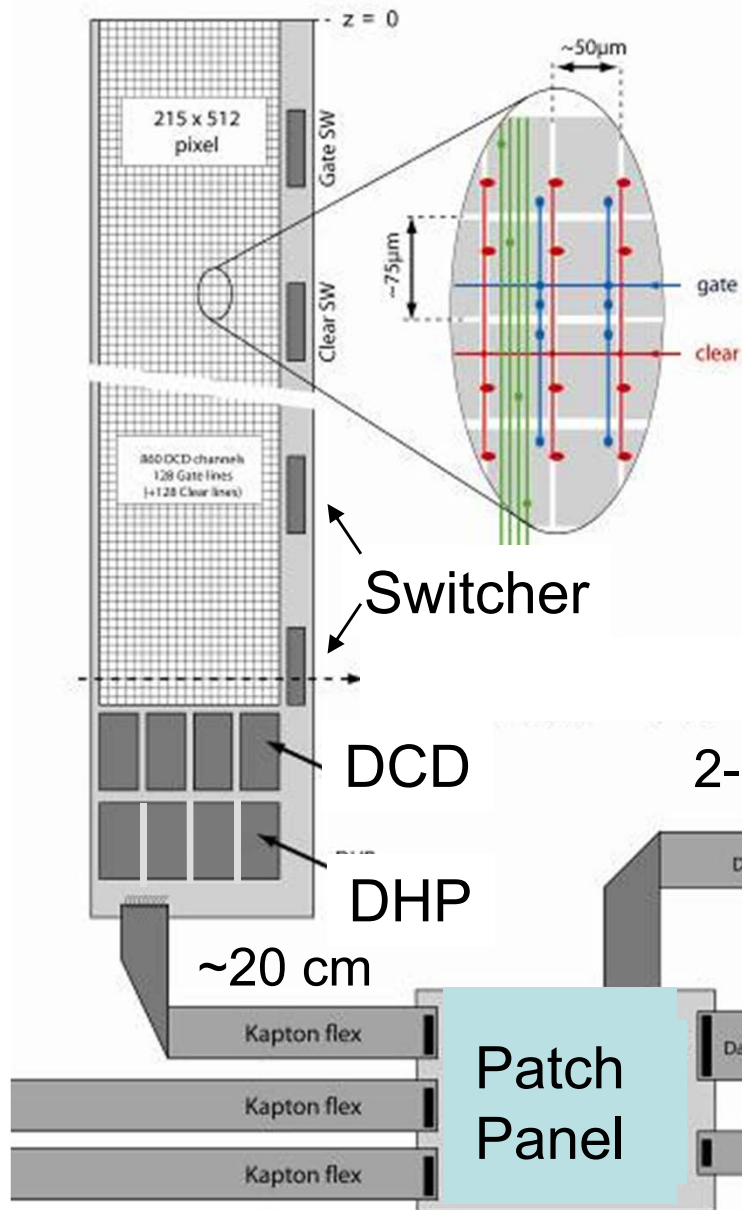


Support and Cooling Structure: Mockup





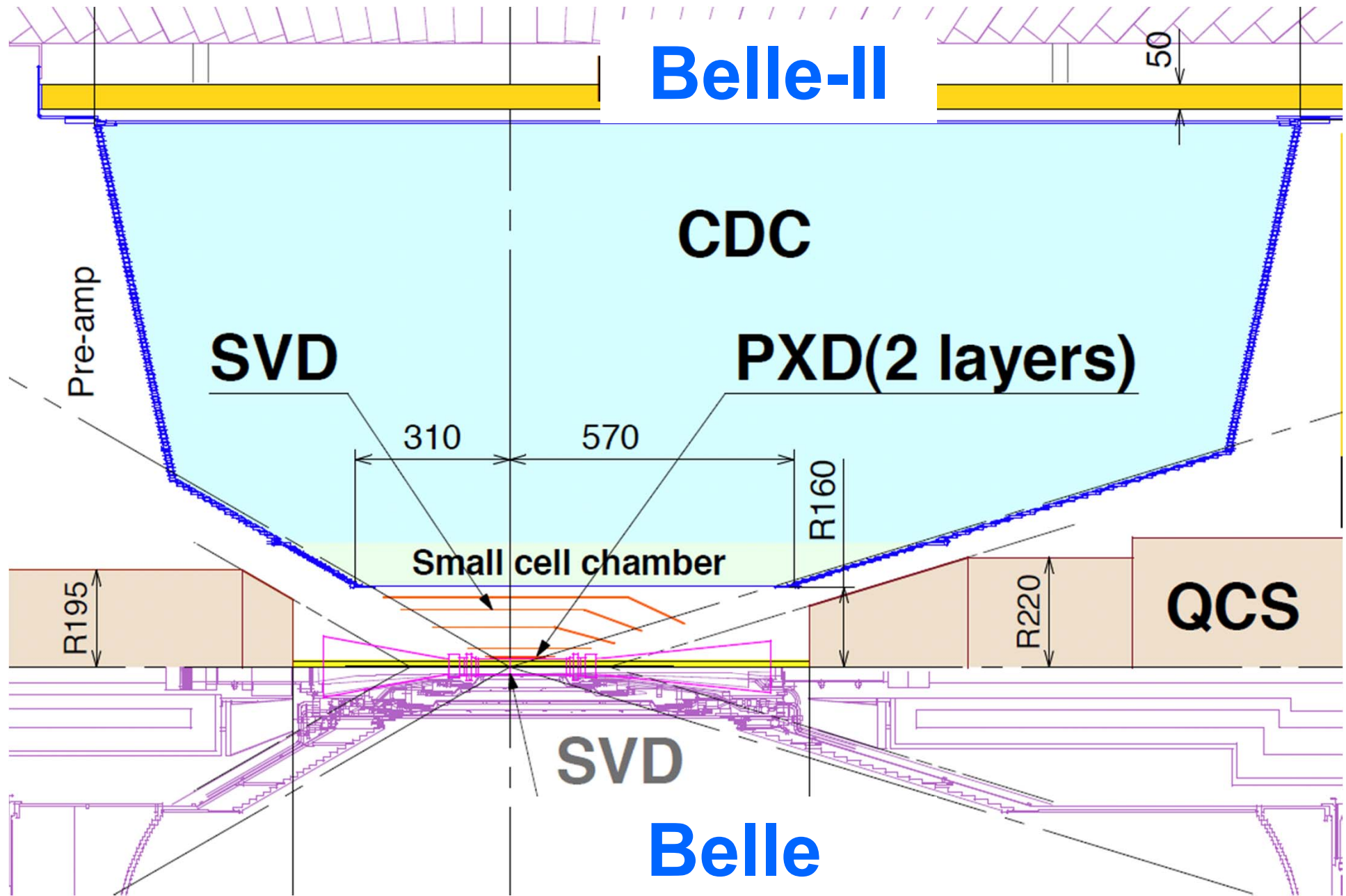
PXD DAQ Chain



- Kapton cable (from DHP to DHH) cannot be longer than ~ 20-30 cm
- need location for the DHH in low radiation area (FPGAs)
- need to design patch pannel (signal transmission Kapton -> TWP)



New Tracking System for Belle-II





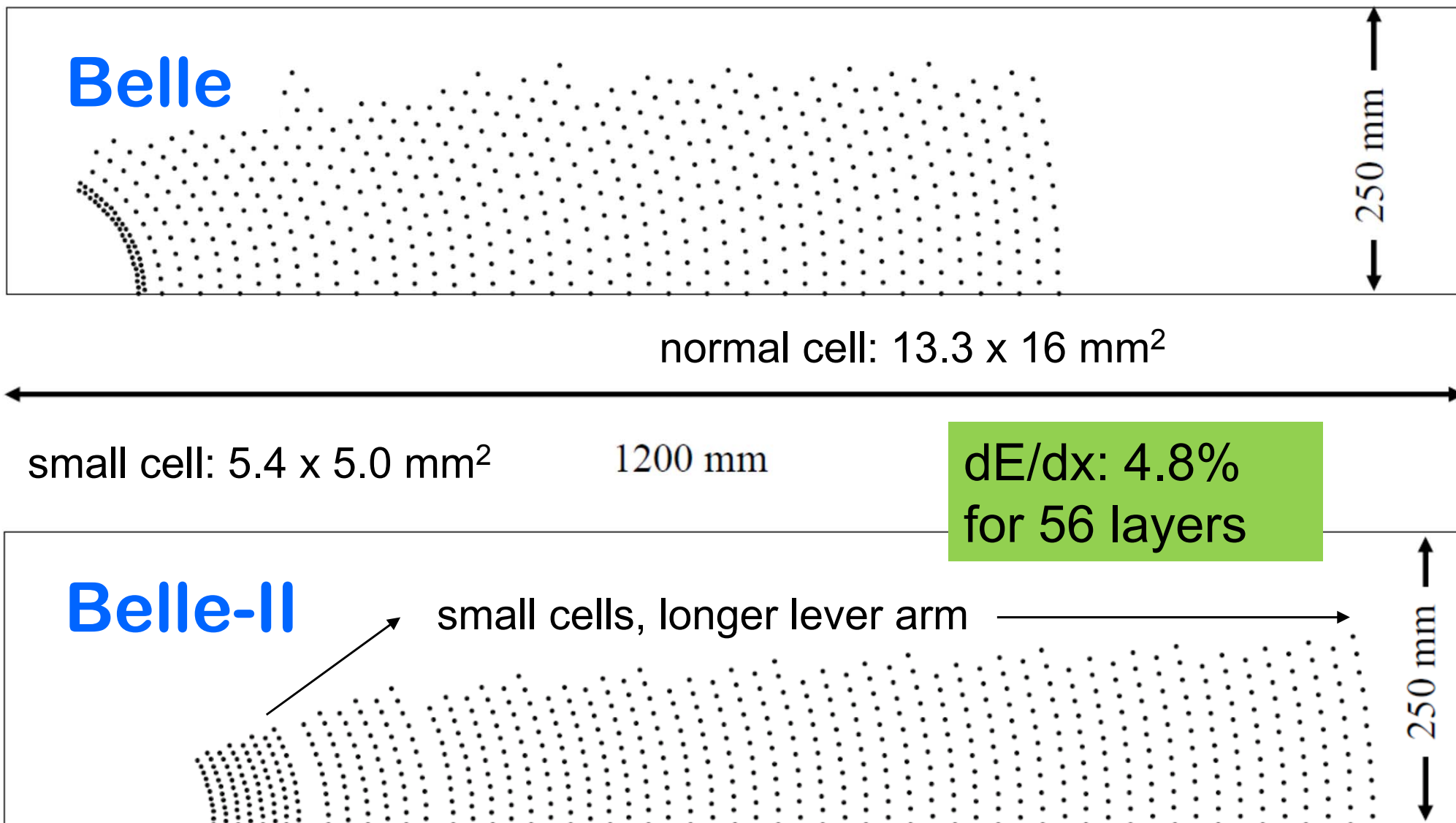
New Central Drift Chamber (CDC)



	Belle	Belle-II
Radius of inner boundary (mm)	77	160
Radius of outer boundary (mm)	880	1096
Radius of inner most sense wire (mm)	88	168
Radius of outer most sense wire (mm)	863	1082
Number of layers	50	58
Number of total sense wires	8400	15104
Effective radius of dE/dx measurement (mm)	752	928
Gas	He-C ₂ H ₆	He-C ₂ H ₆
Diameter of sense wire (μm)	30	30



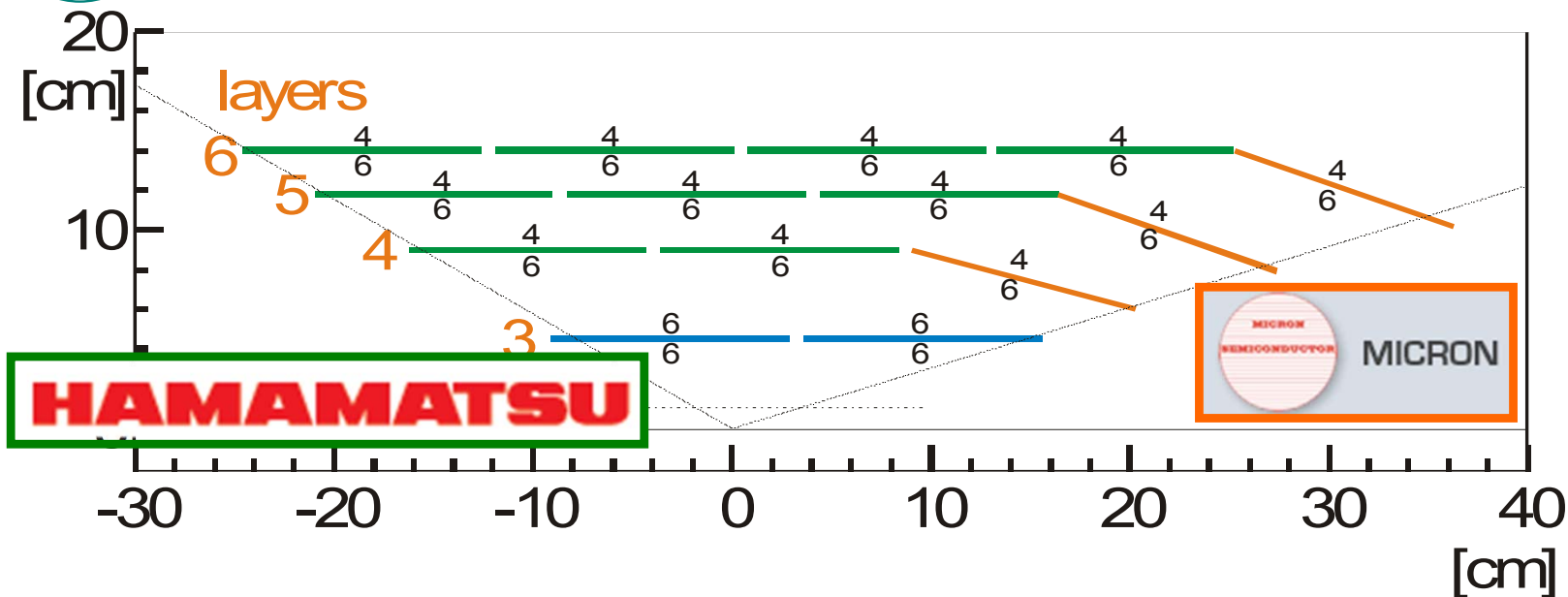
New Central Drift Chamber (CDC)



z-coordinate via standard stereo wire arrangement, charge division planned



New Si System for Belle-II : SuperSVD



300 μm DSSD

Pitch:
 50/160 μm (rect.)
 50-75/160 μm
 (wedge)

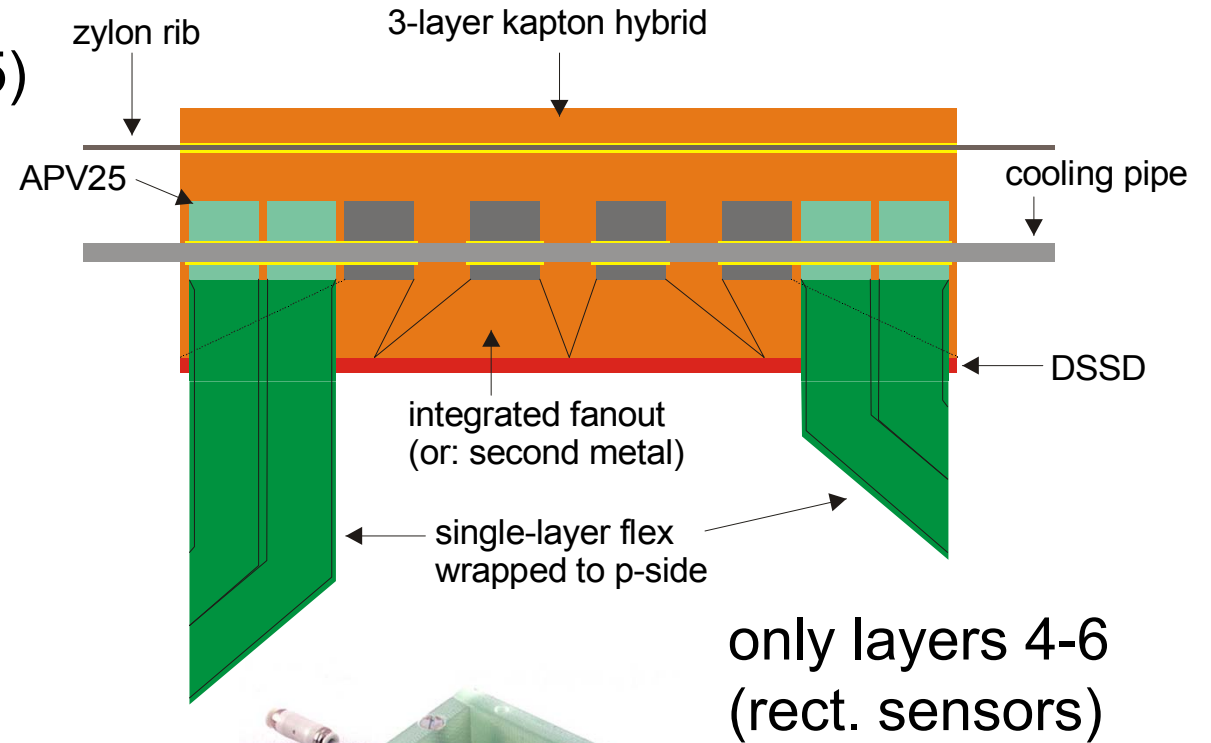
Layer	# Ladders	Rect. Sensors [50 μm]	Rect. Sensors [75 μm]	Wedge Sensors	APVs
6	17	0	68	17	850
5	14	0	42	14	560
4	10	0	20	10	300
3	8	16	0	0	192
Sum:	49	16	130	41	1902



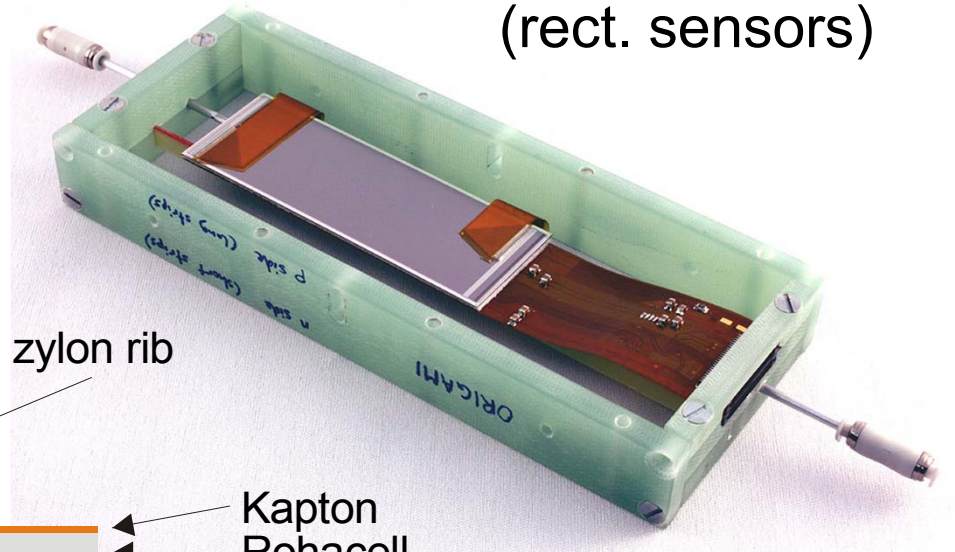
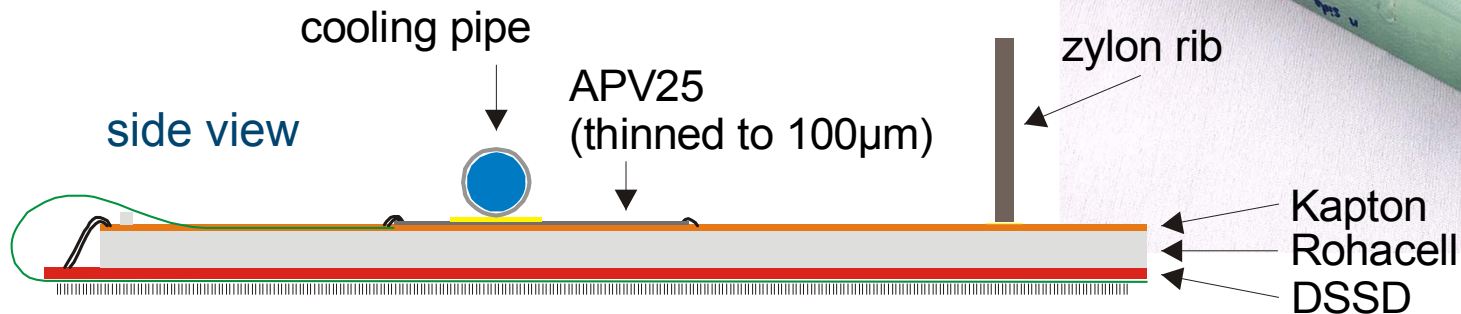
Chip on Sensor: The Origami Concept (SVD)



- Thinned readout chips (APV25) on sensor
- Strips of bottom side are connected by flex fanouts wrapped around the edge
- All readout chips are aligned → single cooling pipe
- Shortest possible connections → high signal-to-noise ratio



Total material budget: 0.6% X_0
(cf. 0.48% for conventional readout)

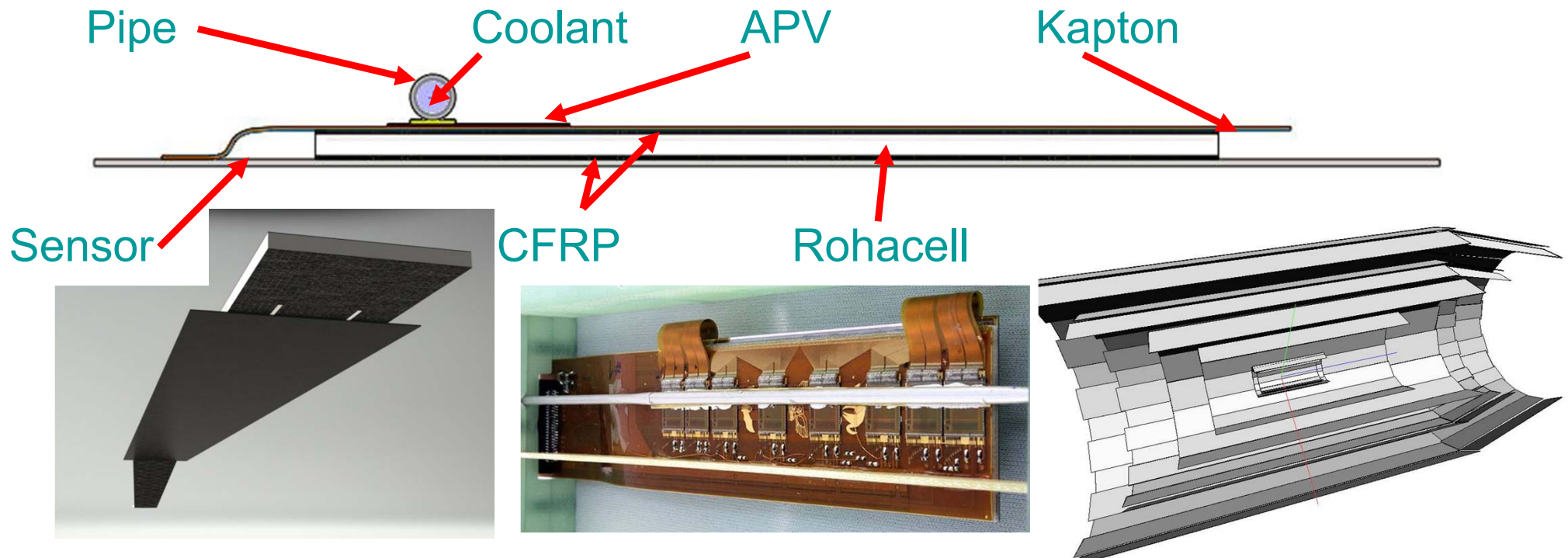
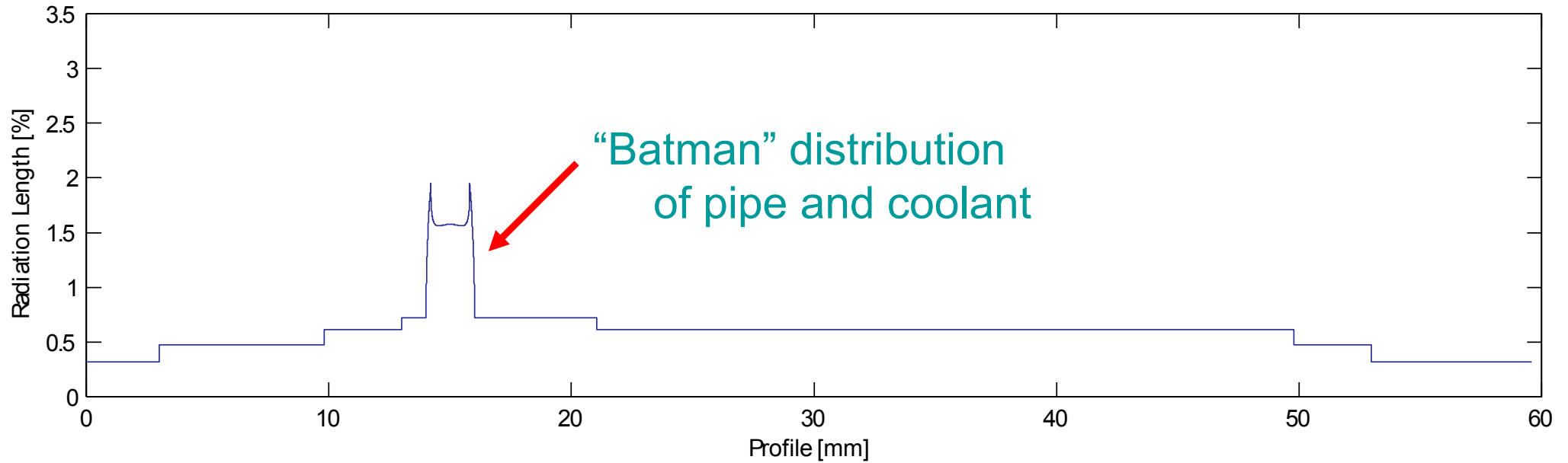




SVD Mechanics and Material Budget

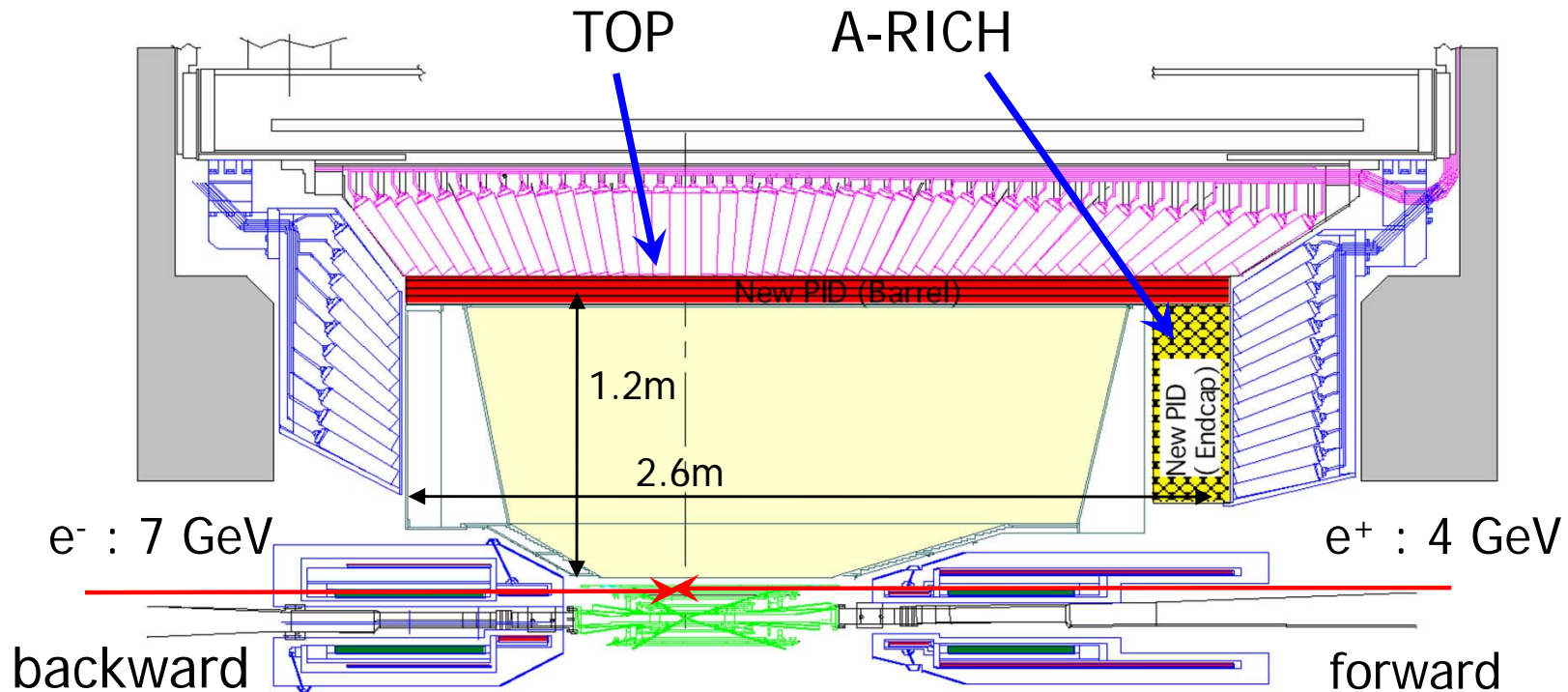


Sandwich Design



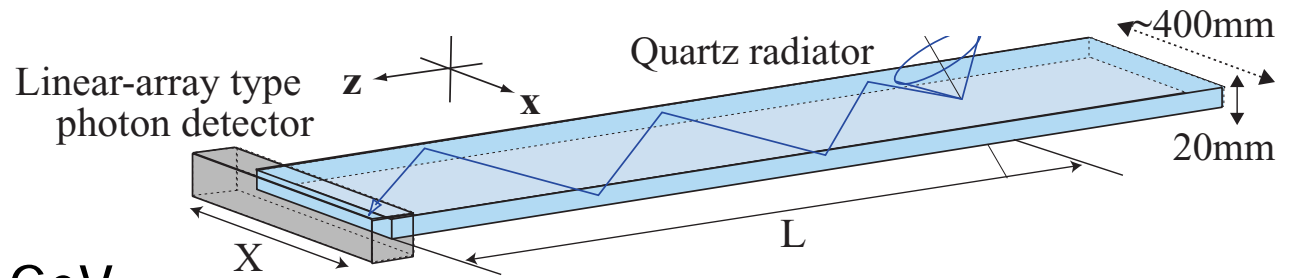


Upgrade: Particle Identification



Goal:

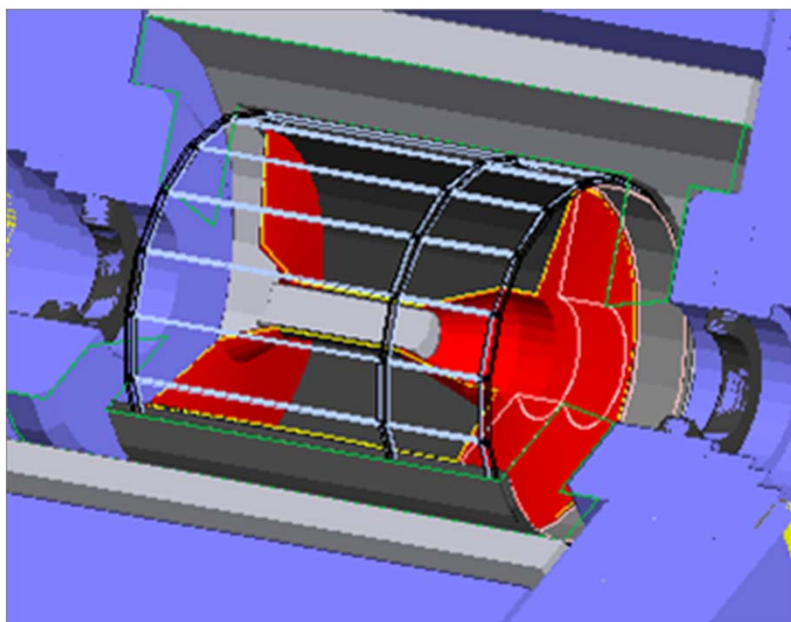
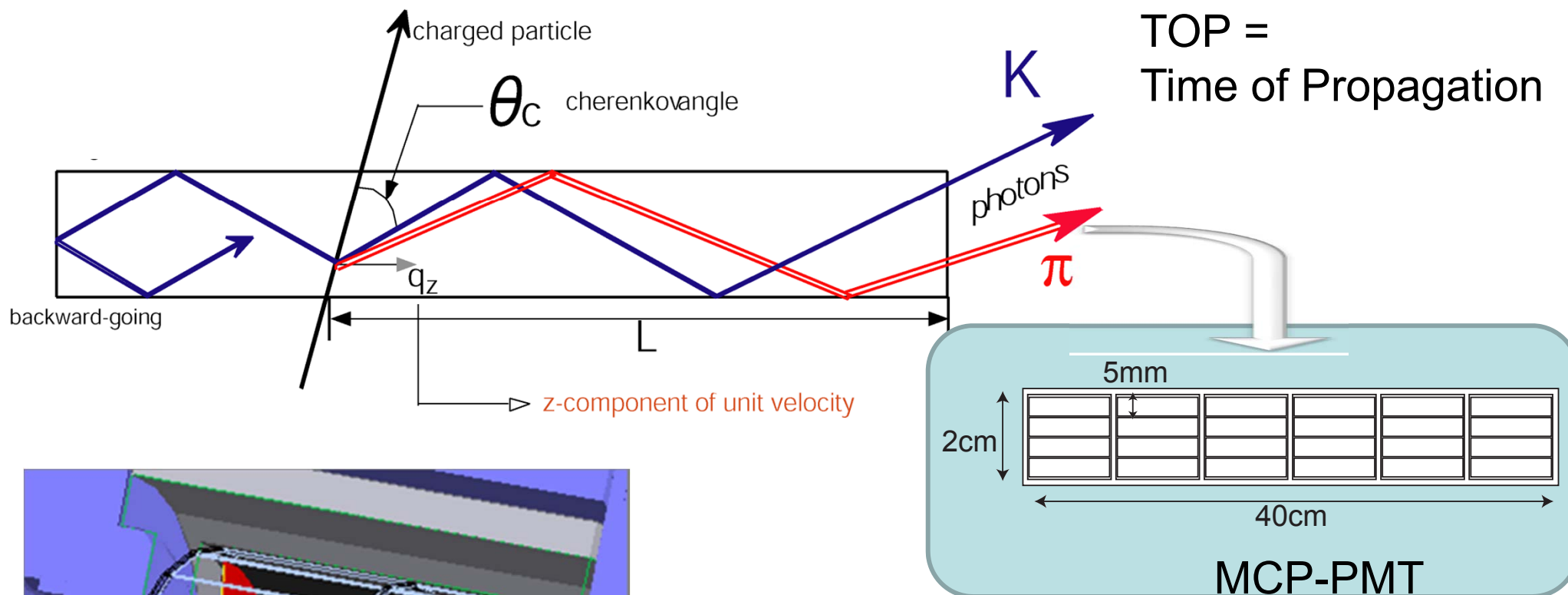
- 3σ K/pi separation (barrel)
- 4σ K/pi separation up to 4 GeV (end caps)



TOP: time of propagation



Baseline Design for Barrel PID (TOP)



Ring imaging with :

- One coordinate with a few mm precision
- Time-of-arrival

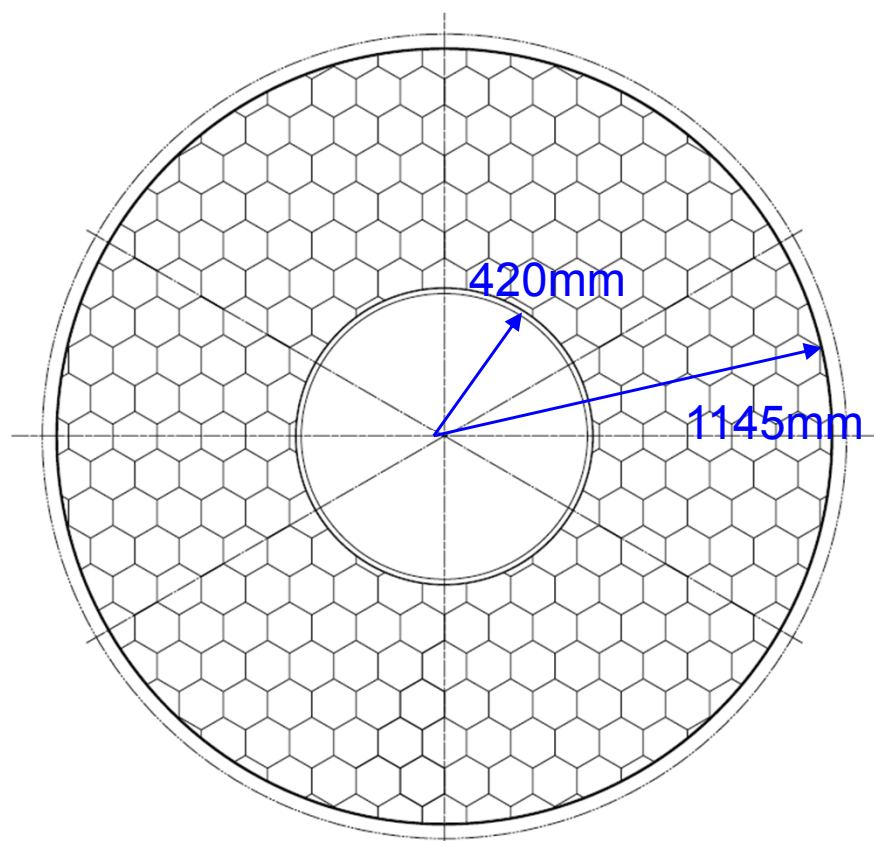
→ Excellent time resolution $< \sim 40\text{ps}$
required for single photon in 1.5T B field



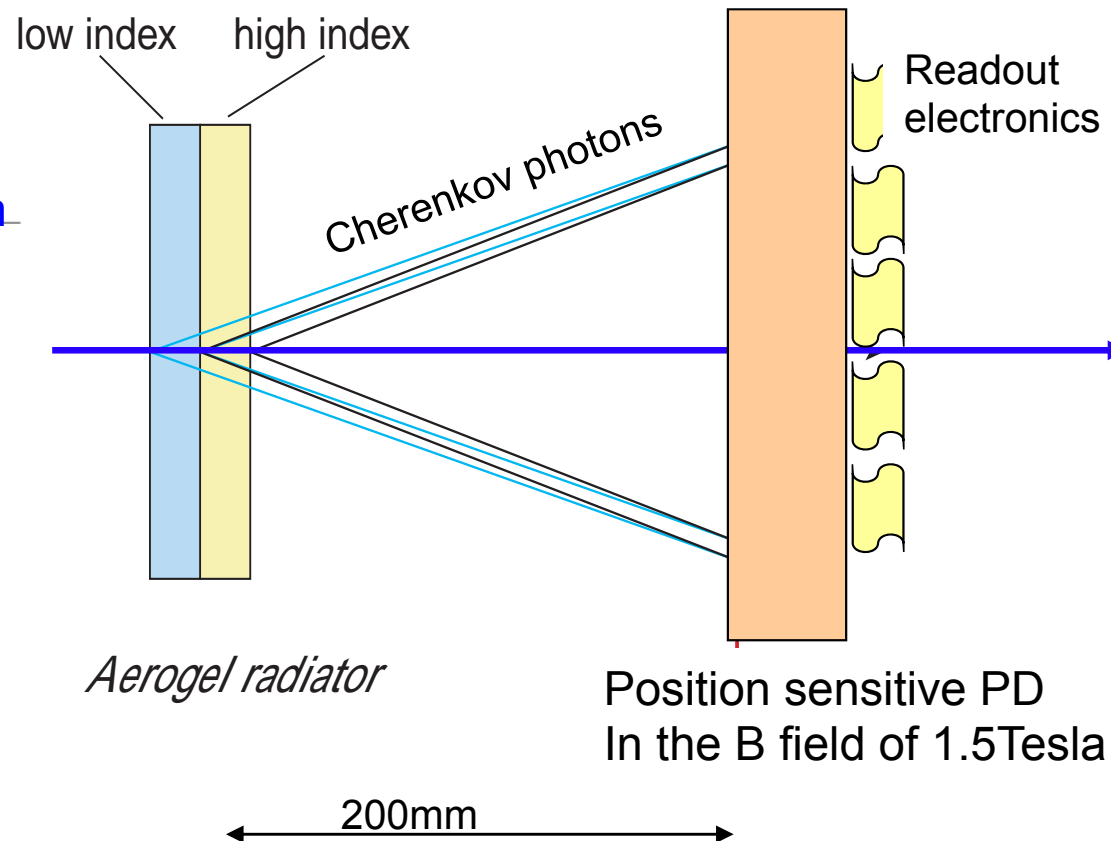
Baseline Design for Endcap PID (A-RICH)



Proximity focusing RICH with silica aerogel as Cherenkov radiator for new Belle forward PID

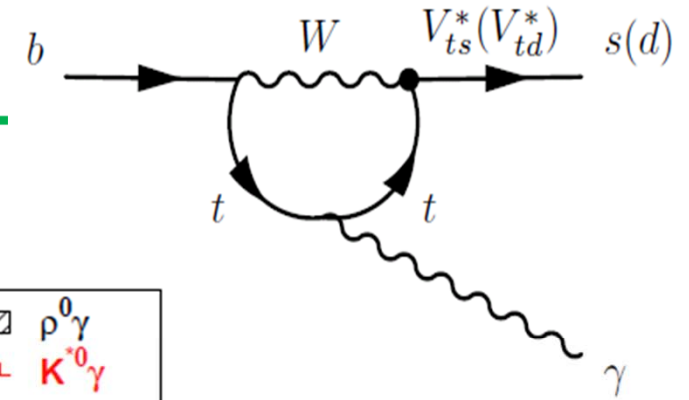


x-y view of forward end-cap



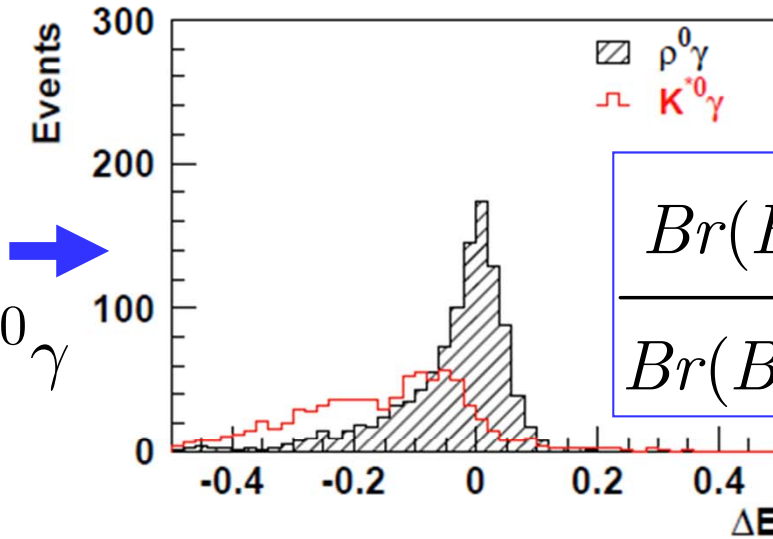
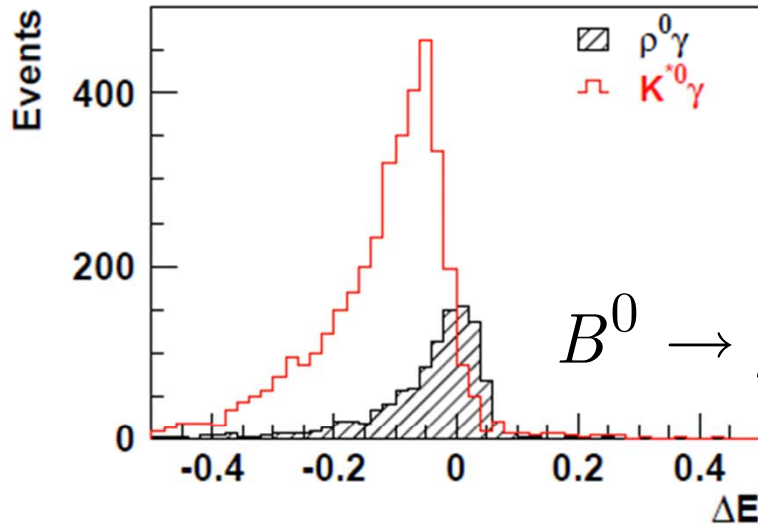


PID Improvement in Belle-II



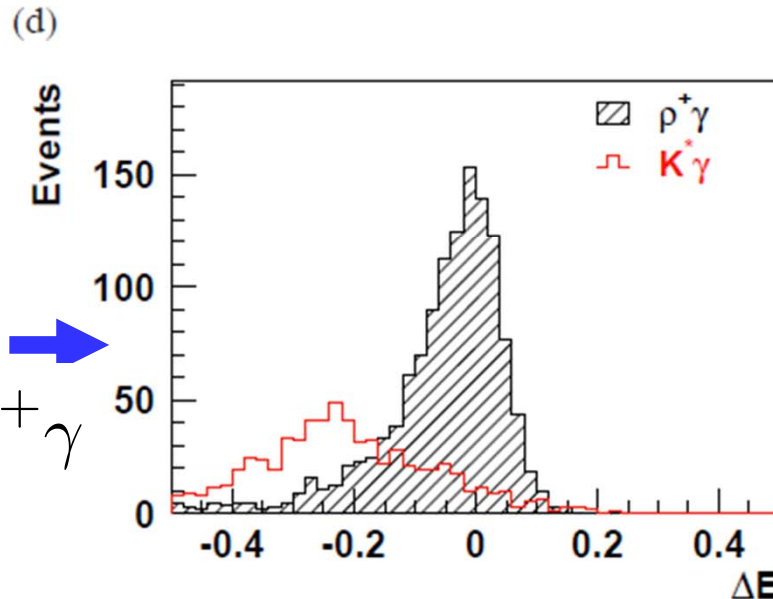
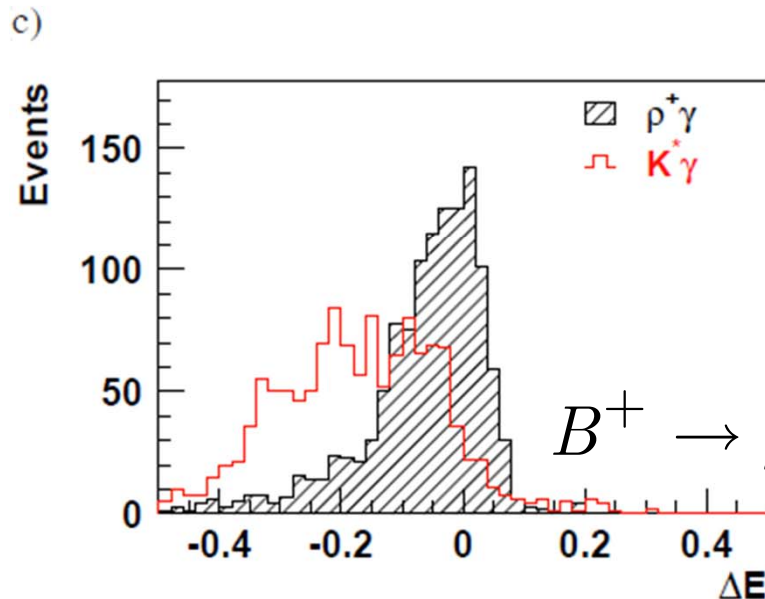
Present Belle PID

Belle II PID



$$\frac{Br(B \rightarrow \rho \gamma)}{Br(B \rightarrow K^* \gamma)} \sim \left| \frac{V_{td}}{V_{ts}} \right|^2$$

(~ 1/40)



$B \rightarrow \rho \gamma$

difficult because
of dominating
 $K^* \gamma$

(Background
from K's
misident. as π 's)



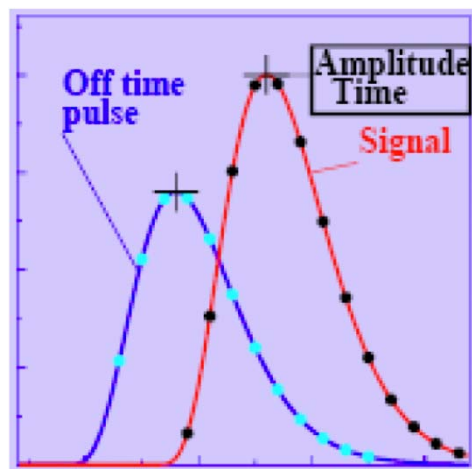
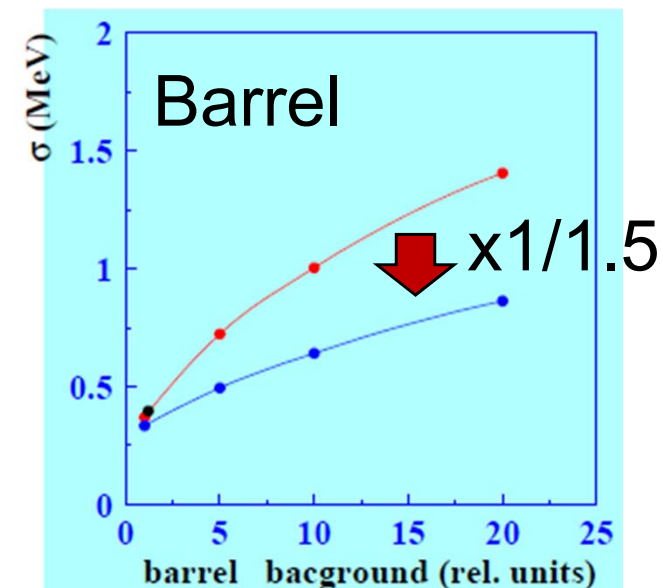
Calorimeter Upgrade (ECL)



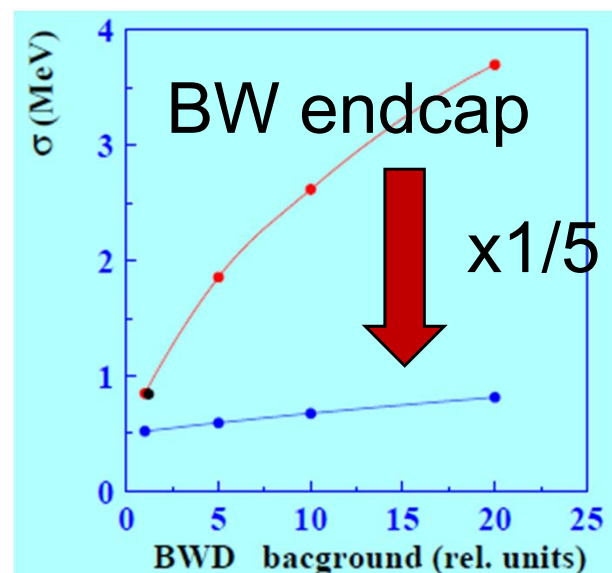
- Increase of dark current due to neutron flux
- Fake clusters & pile-up noise

- Barrel:
500 ns shaping + 2MHz w.f. sampling.
- Endcap:
rad. hard crystals with short decay time (e.g. pure CsI) + photopentodes
30ns shaping + 43MHz w.f. sampling

Pileup Reduction:



FADC: 16 samples

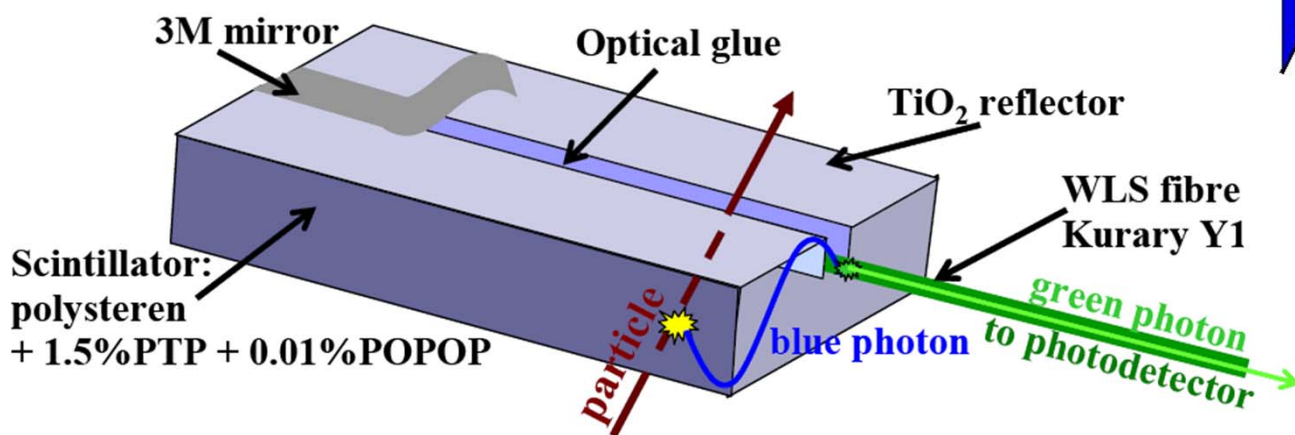




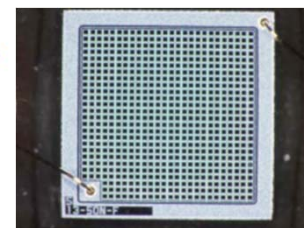
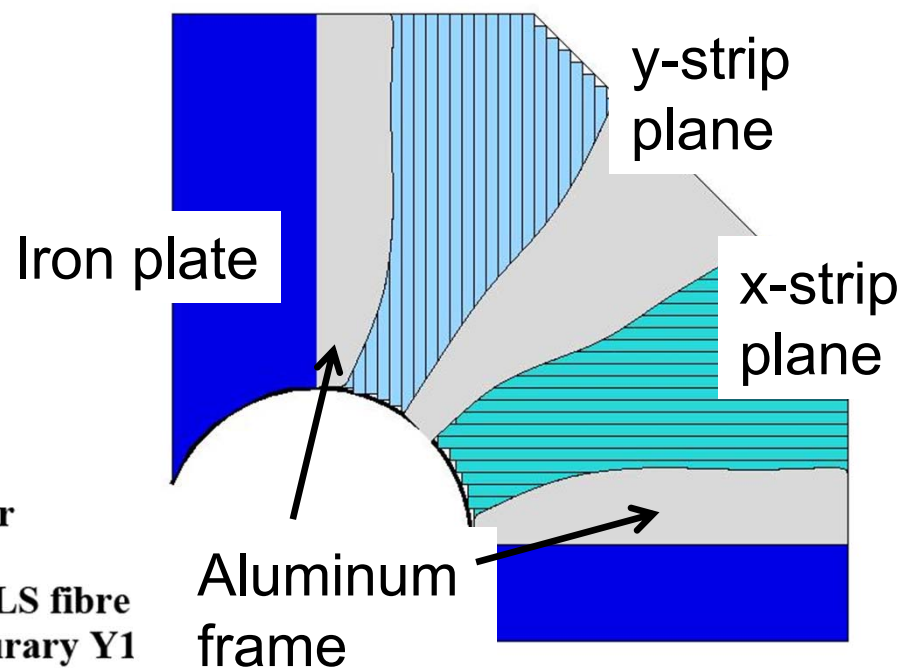
Upgrade of KLM (Endcaps)



- Two independent (x and y) layers in one superlayer made of orthogonal scintillator strips with WLS read out
- Photo-detector: avalanche photodiode in Geiger mode (SiPM)
- ~120 strips in one 90° sector (max L=280cm, w=25mm)
- ~30000 read out channels
- Geometrical acceptance > 99%



676 pixels (20x20 μm^2)



SiPM, e.g. Hamamatsu 1.3x1.3 mm²